SIEMENS

Microcomputer Components

16-Bit CMOS Single-Chip Microcontroller

C167CR

Data Sheet 06.95 Advance Information

Edition 06.95

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32	Register PICON added
37	V_{ILS}, V_{IHS}, HYS, I_{OV} added.
37	R_{RST}, I_{RWH}, I_{RWL}, I_{ALEL}, I_{ALEH}, I_{P6H}, test cond. I_{OZx} changed.
38	I_{P6L}, I_{CC}, I_{ID} changed.
39	I_{CC}, I_{ID} typical values added
40	ADC specification changed.
43...45	PLL description added.
45	External Clock Drive specification changed.
47	t_{14}, t_{15}, t_{16}, t_{17}, t_{22}, t_{39}, t_{46} changed.
47	t_{47} changed.
53	t_{14}, t_{15}, t_{16}, t_{17}, t_{20}, $t_{21,}$ t_{22} changed.
54	t_{39}, t_{46}, t_{47}, t_{55} changed.
57, 58	t_{53} changed to t_{68}.
59	t_{36} changed.
63	t_{63} changed.

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C16x-Family of
High-Performance CMOS 16-Bit Microcontrollers

C167CR

Advance Information
C167CR 16-Bit Microcontroller

- High Performance 16-bit CPU with 4-Stage Pipeline
- 100 ns Instruction Cycle Time at 20 MHz CPU Clock
- 500 ns Multiplication (16 × 16 bit), 1 µs Division (32 / 16 bit)
- Enhanced Boolean Bit Manipulation Facilities
- Additional Instructions to Support HLL and Operating Systems
- Register-Based Design with Multiple Variable Register Banks
- Single-Cycle Context Switching Support
- Clock Generation via on-chip PLL or via direct clock input
- Up to 16 MBytes Linear Address Space for Code and Data
- 2 KBytes On-Chip Internal RAM (IRAM)
- 2 KBytes On-Chip Extension RAM (XRAM)
- Programmable External Bus Characteristics for Different Address Ranges
- 8-Bit or 16-Bit External Data Bus
- Multiplexed or Demultiplexed External Address/Data Buses
- Five Programmable Chip-Select Signals
- Hold- and Hold-Acknowledge Bus Arbitration Support
- 1024 Bytes On-Chip Special Function Register Area
- Idle and Power Down Modes
- 8-Channel Interrupt-Driven Single-Cycle Data Transfer Facilities via Peripheral Event Controller (PEC)
- 16-Priority-Level Interrupt System with 56 Sources, Sample-Rate down to 50 ns
- 16-Channel 10-bit A/D Converter with 9.7 µs Conversion Time
- Two 16-Channel Capture/Compare Units
- 4-Channel PWM Unit
- Two Multi-Functional General Purpose Timer Units with 5 Timers
- Two Serial Channels (Synchronous/Asynchronous and High-Speed-Synchronous)
- On-Chip CAN Interface with 15 Message Objects (Full-CAN/Basic-CAN)
- Programmable Watchdog Timer
- Up to 111 General Purpose I/O Lines, partly with Selectable Input Thresholds and Hysteresis
- Supported by a Wealth of Development Tools like C-Compilers, Macro-Assembler Packages, Emulators, Evaluation Boards, HLL-Debuggers, Simulators, Logic Analyzer Disassemblers, Programming Boards
- On-Chip Bootstrap Loader
- 144-Pin MQFP Package (EIAJ)

This document describes the **SAB-C167CR-LM**, the **SAF-C167CR-LM** and the **SAK-C167CR-LM**. For simplicity all versions are referred to by the term **C167CR** throughout this document.

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57, 58	t_{53} changed to t_{68}.
59	t_{36} changed.
63	t_{63} changed.

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Introduction

The C167CR is a new derivative of the Siemens C16x Family of full featured single-chip CMOS microcontrollers. It combines high CPU performance (up to 10 million instructions per second) with high peripheral functionality and enhanced IO-capabilities. It also provides on-chip high-speed RAM and clock generation via PLL.

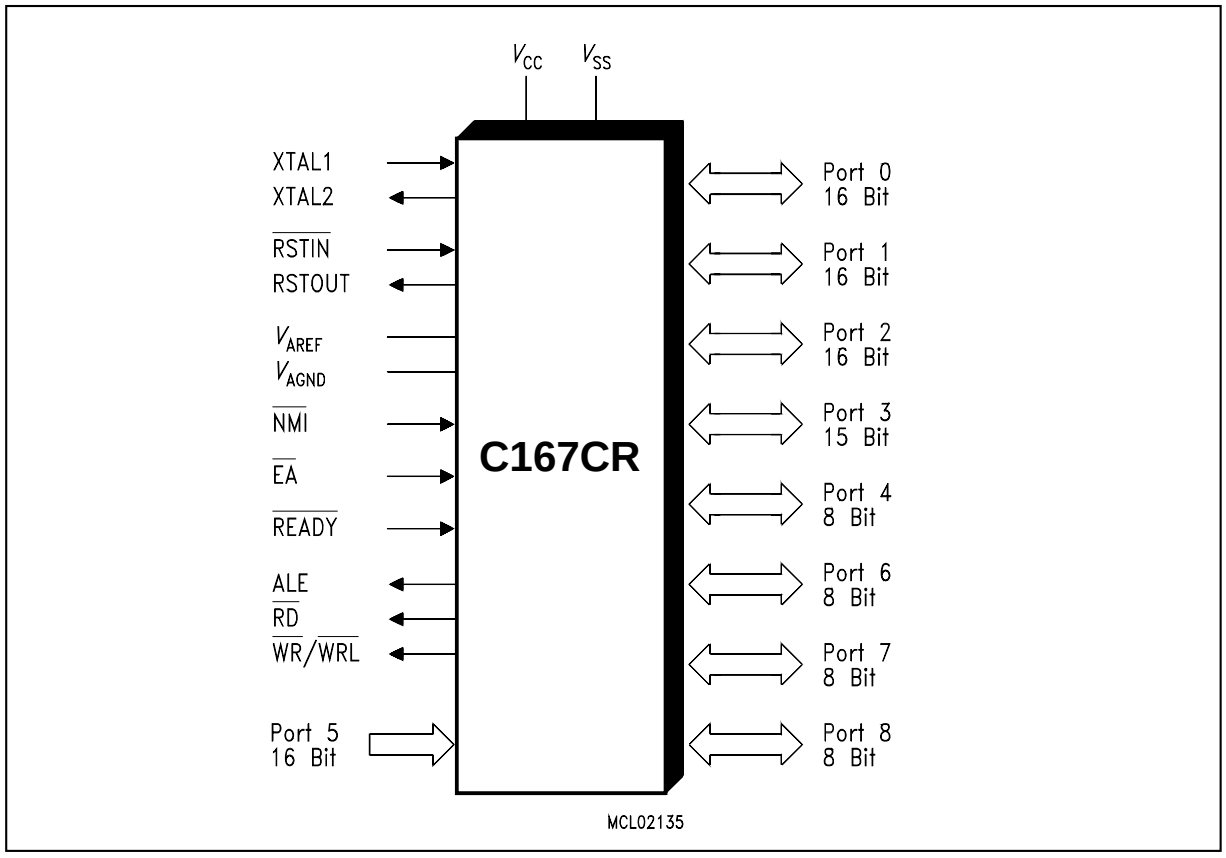


Figure 1
Logic Symbol

Ordering Information

Type	Ordering Code	Package	Function
SAB-C167CR-LM	Q67121-C942	P-MQFP-144-1	16-bit microcontroller with 2 × 2 KByte RAM Temperature range 0 to + 70 °C
SAF-C167CR-LM	Q67121-C946	P-MQFP-144-1	16-bit microcontroller with 2 × 2 KByte RAM Temperature range – 40 to + 85 °C
SAK-C167CR-LM	Q67121-C967	P-MQFP-144-1	16-bit microcontroller with 2 × 2 KByte RAM Temperature range – 40 to + 125 °C

Pin Configuration
(top view)

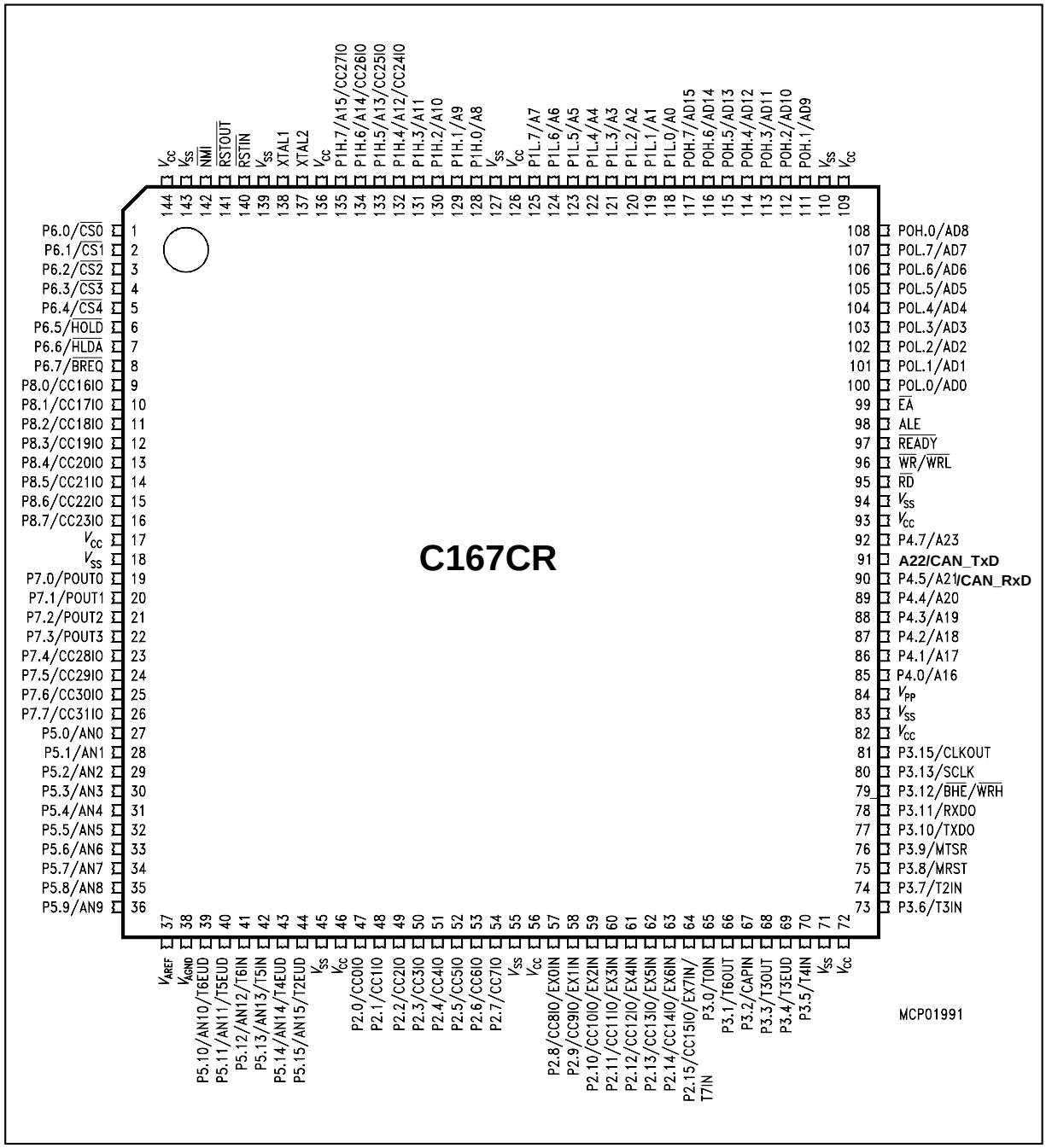


Figure 2

Pin Definitions and Functions

Symbol	Pin Number	Input (I) Output (O)	Function
P6.0 - P6.7	1 - 8	I/O	Port 6 is an 8-bit bidirectional I/O port. It is bit-wise programmable for input or output via direction bits. For a pin configured as input, the output driver is put into high-impedance state. Port 6 outputs can be configured as push/pull or open drain drivers. The following Port 6 pins also serve for alternate functions: P6.0 $\overline{CS0}$ Chip Select 0 Output ... ... P6.4 $\overline{CS4}$ Chip Select 4 Output P6.5 $\overline{HOLD}$ External Master Hold Request Input P6.6 $\overline{HLDA}$ Hold Acknowledge Output P6.7 $\overline{BREQ}$ Bus Request Output
	1	O	
	...	...	
	5	O	
	6	I	
	7	O	
	8	O	
P8.0 - P8.7	9 - 16	I/O	Port 8 is an 8-bit bidirectional I/O port. It is bit-wise programmable for input or output via direction bits. For a pin configured as input, the output driver is put into high-impedance state. Port 8 outputs can be configured as push/pull or open drain drivers. The input threshold of Port 8 is selectable (TTL or special). The following Port 8 pins also serve for alternate functions: P8.0 CC16IO CAPCOM2: CC16 Cap.-In/Comp.Out ... ... P8.7 CC23IO CAPCOM2: CC23 Cap.-In/Comp.Out
	9	I/O	
	...	...	
	16	I/O	
P7.0 - P7.7	19 - 26	I/O	Port 7 is an 8-bit bidirectional I/O port. It is bit-wise programmable for input or output via direction bits. For a pin configured as input, the output driver is put into high-impedance state. Port 7 outputs can be configured as push/pull or open drain drivers. The input threshold of Port 7 is selectable (TTL or special). The following Port 7 pins also serve for alternate functions: P7.0 POUT0 PWM Channel 0 Output ... ... P7.3 POUT3 PWM Channel 3 Output P7.4 CC28IO CAPCOM2: CC28 Cap.-In/Comp.Out ... ... P7.7 CC31IO CAPCOM2: CC31 Cap.-In/Comp.Out
	19	O	
	...	...	
	22	O	
	23	I/O	
	...	...	
	26	I/O	

Pin Definitions and Functions (cont'd)

Symbol	Pin Number	Input (I) Output (O)	Function		
P5.0 - P5.15	27 - 36 39 - 44	I I	Port 5 is a 16-bit input-only port with Schmitt-Trigger characteristics. The pins of Port 5 also serve as the (up to 16) analog input channels for the A/D converter, where P5.x equals ANx (Analog input channel x), or they serve as timer inputs:		
	39	I	P5.10	T6EUD	GPT2 Timer T6 Ext.Up/Down Ctrl.Input
	40	I	P5.11	T5EUD	GPT2 Timer T5 Ext.Up/Down Ctrl.Input
	41	I	P5.12	T6IN	GPT2 Timer T6 Count Input
	42	I	P5.13	T5IN	GPT2 Timer T5 Count Input
	43	I	P5.14	T4EUD	GPT1 Timer T4 Ext.Up/Down Ctrl.Input
	44	I	P5.15	T2EUD	GPT1 Timer T2 Ext.Up/Down Ctrl.Input
P2.0 - P2.15	47 - 54 57 - 64	I/O	Port 2 is a 16-bit bidirectional I/O port. It is bit-wise programmable for input or output via direction bits. For a pin configured as input, the output driver is put into high-impedance state. Port 2 outputs can be configured as push/pull or open drain drivers. The input threshold of Port 2 is selectable (TTL or special). The following Port 2 pins also serve for alternate functions:		
	47	I/O	P2.0	CC0IO	CAPCOM: CC0 Cap.-In/Comp.Out
	...	...	...	...	...
	54	I/O	P2.7	CC7IO	CAPCOM: CC7 Cap.-In/Comp.Out
	57	I/O I	P2.8	CC8IO EX0IN	CAPCOM: CC8 Cap.-In/Comp.Out, Fast External Interrupt 0 Input
	...	...	...	...	...
	64	I/O I I	P2.15	CC15IO EX7IN T7IN	CAPCOM: CC15 Cap.-In/Comp.Out, Fast External Interrupt 7 Input CAPCOM2 Timer T7 Count Input

Pin Definitions and Functions (cont'd)

Symbol	Pin Number	Input (I) Output (O)	Function		
P3.0 - P3.13, P3.15	65 - 70, 73 - 80, 81	I/O I/O I/O	Port 3 is a 15-bit (P3.14 is missing) bidirectional I/O port. It is bit-wise programmable for input or output via direction bits. For a pin configured as input, the output driver is put into high-impedance state. Port 3 outputs can be configured as push/pull or open drain drivers. The input threshold of Port 3 is selectable (TTL or special). The following Port 3 pins also serve for alternate functions:		
	65	I	P3.0	T0IN	CAPCOM Timer T0 Count Input
	66	O	P3.1	T6OUT	GPT2 Timer T6 Toggle Latch Output
	67	I	P3.2	CAPIN	GPT2 Register CAPREL Capture Input
	68	O	P3.3	T3OUT	GPT1 Timer T3 Toggle Latch Output
	69	I	P3.4	T3EUD	GPT1 Timer T3 Ext.Up/Down Ctrl.Input
	70	I	P3.5	T4IN	GPT1 Timer T4 Input for Count/Gate/Reload/Capture
	73	I	P3.6	T3IN	GPT1 Timer T3 Count/Gate Input
	74	I	P3.7	T2IN	GPT1 Timer T2 Input for Count/Gate/Reload/Capture
	75	I/O	P3.8	MRST	SSC Master-Rec./Slave-Transmit I/O
	76	I/O	P3.9	MTSR	SSC Master-Transmit/Slave-Rec. O/I
	77	O	P3.10	T×D0	ASC0 Clock/Data Output (Asyn./Syn.)
	78	I/O	P3.11	R×D0	ASC0 Data Input (Asyn.) or I/O (Syn.)
	79	O	P3.12	$\overline{BHE}$	Ext. Memory High Byte Enable Signal,
		O		$\overline{WRH}$	Ext. Memory High Byte Write Strobe
	80	I/O	P3.13	SCLK	SSC Master Clock Outp./Slave Cl. Inp.
	81	O	P3.15	CLKOUT	System Clock Output (=CPU Clock)
P4.0 - P4.7	85 - 92	I/O	Port 4 is an 8-bit bidirectional I/O port. It is bit-wise programmable for input or output via direction bits. For a pin configured as input, the output driver is put into high-impedance state. In case of an external bus configuration, Port 4 can be used to output the segment address lines:		
	85	O	P4.0		Least Significant Segment Addr. Line
	...	...	...	...	...
	89	O	P4.4	A16	Least Significant Segment Addr. Line
	90	O	P4.5	A21	Segment Address Line,
		I		CAN_RxD	CAN Receive Data Input
	91	O	P4.6	A22	Segment Address Line,
		O		CAN_TxD	CAN Transmit Data Output
	92	O	P4.7	A23	Most Significant Segment Addr. Line
$\overline{RD}$	95	O	External Memory Read Strobe. $\overline{RD}$ is activated for every external instruction or data read access.		

Pin Definitions and Functions (cont'd)

Symbol	Pin Number	Input (I) Output (O)	Function
$\overline{WR}$/ $\overline{WRL}$	96	O	External Memory Write Strobe. In $\overline{WR}$-mode this pin is activated for every external data write access. In $\overline{WRL}$-mode this pin is activated for low byte data write accesses on a 16-bit bus, and for every data write access on an 8-bit bus. See WRCFG in register SYSCON for mode selection.
$\overline{READY}$	97	I	Ready Input. When the Ready function is enabled, a high level at this pin during an external memory access will force the insertion of memory cycle time waitstates until the pin returns to a low level.
ALE	98	O	Address Latch Enable Output. Can be used for latching the address into external memory or an address latch in the multiplexed bus modes.
$\overline{EA}$	99	I	External Access Enable pin. A low level at this pin during and after Reset forces the C167CR to begin instruction execution out of external memory. A high level forces execution out of the internal ROM. ROMless versions must have this pin tied to '0'.
PORT0: P0L.0 - P0L.7, P0H.0 - P0H.7	100 - 107 108, 111-117	I/O	PORT0 consists of the two 8-bit bidirectional I/O ports P0L and P0H. It is bit-wise programmable for input or output via direction bits. For a pin configured as input, the output driver is put into high-impedance state. In case of an external bus configuration, PORT0 serves as the address (A) and address/data (AD) bus in multiplexed bus modes and as the data (D) bus in demultiplexed bus modes. **Demultiplexed bus modes:** Data Path Width: 8-bit 16-bit P0L.0 - P0L.7: D0 - D7 D0 - D7 P0H.0 - P0H.7: I/O D8 - D15 **Multiplexed bus modes:** Data Path Width: 8-bit 16-bit P0L.0 - P0L.7: AD0 - AD7 AD0 - AD7 P0H.0 - P0H.7: A8 - A15 AD8 - AD15

Pin Definitions and Functions (cont'd)

Symbol	Pin Number	Input (I) Output (O)	Function
PORT1: P1L.0 - P1L.7, P1H.0 - P1H.7	 118 - 125 128 - 135	I/O	PORT1 consists of the two 8-bit bidirectional I/O ports P1L and P1H. It is bit-wise programmable for input or output via direction bits. For a pin configured as input, the output driver is put into high-impedance state. PORT1 is used as the 16-bit address bus (A) in demultiplexed bus modes and also after switching from a demultiplexed bus mode to a multiplexed bus mode. The following PORT1 pins also serve for alternate functions:
	132	I	P1H.4 CC24IO CAPCOM2: CC24 Capture Input
	133	I	P1H.5 CC25IO CAPCOM2: CC25 Capture Input
	134	I	P1H.6 CC26IO CAPCOM2: CC26 Capture Input
	135	I	P1H.7 CC27IO CAPCOM2: CC27 Capture Input
XTAL1	138	I	XTAL1: Input to the oscillator amplifier and input to the internal clock generator
XTAL2	137	O	XTAL2: Output of the oscillator amplifier circuit. To clock the device from an external source, drive XTAL1, while leaving XTAL2 unconnected. Minimum and maximum high/low and rise/fall times specified in the AC Characteristics must be observed.
$\overline{\text{RSTIN}}$	140	I	Reset Input with Schmitt-Trigger characteristics. A low level at this pin for a specified duration while the oscillator is running resets the C167CR. An internal pullup resistor permits power-on reset using only a capacitor connected to V_{SS}.
$\overline{\text{RSTOUT}}$	141	O	Internal Reset Indication Output. This pin is set to a low level when the part is executing either a hardware-, a software- or a watchdog timer reset. $\overline{\text{RSTOUT}}$ remains low until the EINIT (end of initialization) instruction is executed.
$\overline{\text{NMI}}$	142	I	Non-Maskable Interrupt Input. A high to low transition at this pin causes the CPU to vector to the NMI trap routine. When the PWRDN (power down) instruction is executed, the $\overline{\text{NMI}}$ pin must be low in order to force the C167CR to go into power down mode. If $\overline{\text{NMI}}$ is high, when PWRDN is executed, the part will continue to run in normal mode. If not used, pin $\overline{\text{NMI}}$ should be pulled high externally.
V_{AREF}	37	–	Reference voltage for the A/D converter.
V_{AGND}	38	–	Reference ground for the A/D converter.
V_{PP}	84	–	Flash programming voltage. This pin accepts the programming voltage for flash versions of the C167CR. **Note:** This pin is not connected (**NC**) on non-flash versions.

Pin Definitions and Functions (cont'd)

Symbol	Pin Number	Input (I) Output (O)	Function
V_{CC}	17, 46, 56, 72, 82, 93, 109, 126, 136, 144	–	Digital Supply Voltage: + 5 V during normal operation and idle mode. ≥ 2.5 V during power down mode.
V_{SS}	18, 45, 55, 71, 83, 94, 110, 127, 139, 143	–	Digital Ground.

Functional Description

The architecture of the C167CR combines advantages of both RISC and CISC processors and of advanced peripheral subsystems in a very well-balanced way. The following block diagram gives an overview of the different on-chip components and of the advanced, high bandwidth internal bus structure of the C167CR.

Note: All time specifications refer to a CPU clock of 20 MHz
(see definition in the AC Characteristics section).

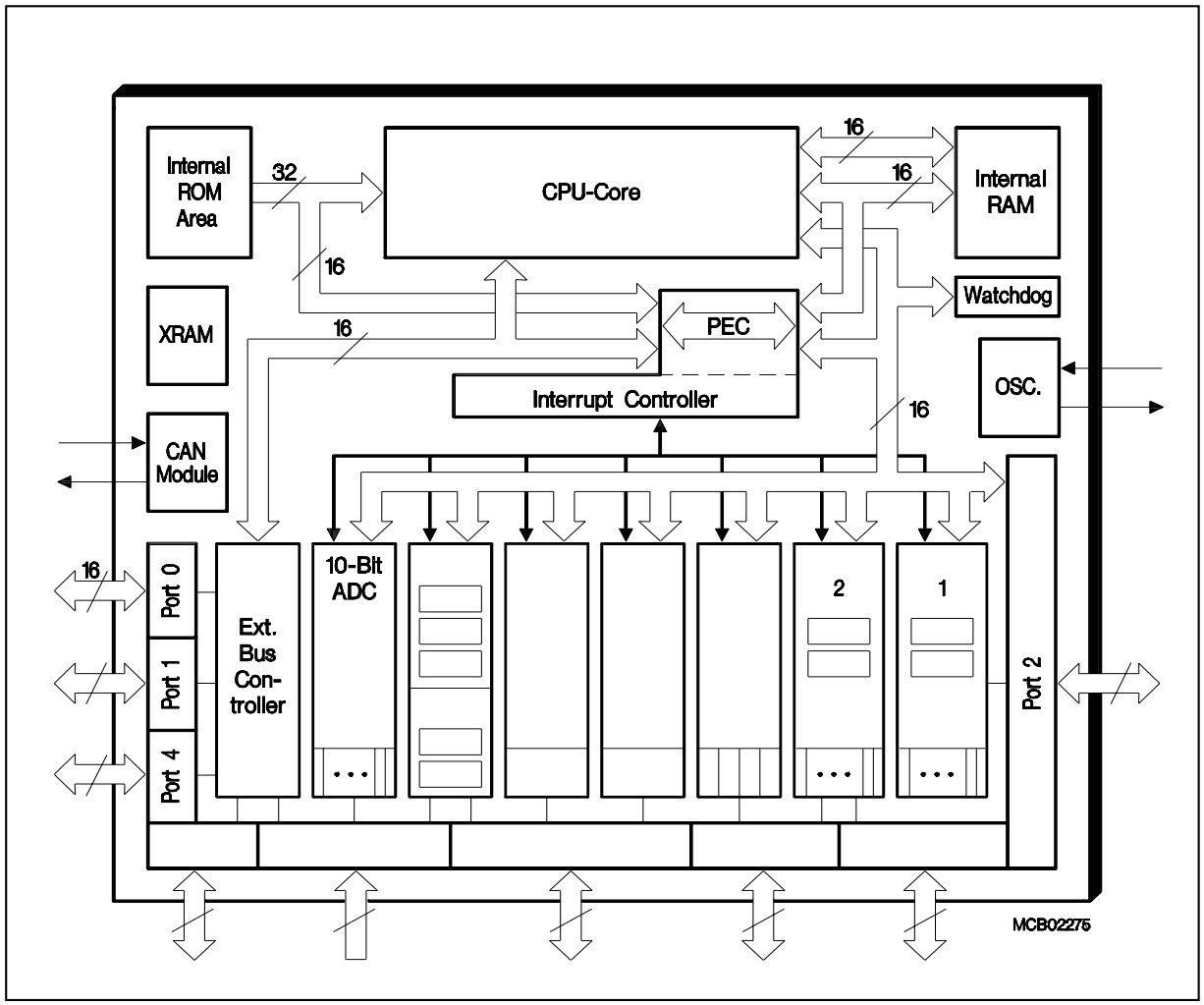


Figure 3
Block Diagram

Memory Organization

The memory space of the C167CR is configured in a Von Neumann architecture which means that code memory, data memory, registers and I/O ports are organized within the same linear address space which includes 16 MBytes. The entire memory space can be accessed bytewise or wordwise. Particular portions of the on-chip memory have additionally been made directly bitaddressable.

The C167CR is prepared to incorporate on-chip mask-programmable ROM or Flash Memory for code or constant data. Currently no ROM is integrated.

2 KBytes of on-chip Internal RAM are provided as a storage for user defined variables, for the system stack, general purpose register banks and even for code. A register bank can consist of up to 16 wordwide (R0 to R15) and/or bytewide (RL0, RH0, …, RL7, RH7) so-called General Purpose Registers (GPRs).

1024 bytes (2 $\times$ 512 bytes) of the address space are reserved for the Special Function Register areas (SFR space and ESFR space). SFRs are wordwide registers which are used for controlling and monitoring functions of the different on-chip units. Unused SFR addresses are reserved for future members of the C16x family.

2 KBytes of on-chip Extension RAM (XRAM) are provided to store user data, user stacks or code. The XRAM is accessed like external memory and therefore cannot be used for the system stack or for register banks and is not bitadressable. The XRAM allows 16-bit accesses with maximum speed.

In order to meet the needs of designs where more memory is required than is provided on chip, up to 16 MBytes of external RAM and/or ROM can be connected to the microcontroller.

External Bus Controller

All of the external memory accesses are performed by a particular on-chip External Bus Controller (EBC). It can be programmed either to Single Chip Mode when no external memory is required, or to one of four different external memory access modes, which are as follows:

– 16-/18-/20-/24-bit Addresses, 16-bit Data, Demultiplexed
– 16-/18-/20-/24-bit Addresses, 16-bit Data, Multiplexed
– 16-/18-/20-/24-bit Addresses, 8-bit Data, Multiplexed
– 16-/18-/20-/24-bit Addresses, 8-bit Data, Demultiplexed

In the demultiplexed bus modes, addresses are output on PORT1 and data is input/output on PORT0. In the multiplexed bus modes both addresses and data use PORT0 for input/output.

Important timing characteristics of the external bus interface (Memory Cycle Time, Memory Tri-State Time, Length of ALE and Read Write Delay) have been made programmable to allow the user the adaption of a wide range of different types of memories. In addition, different address ranges may be accessed with different bus characteristics. Up to 5 external $\overline{CS}$ signals can be generated in order to save external glue logic. Access to very slow memories is supported via a particular ‘Ready’ function. A $\overline{HOLD}$/$\overline{HLDA}$ protocol is available for bus arbitration.

For applications which require less than 16 MBytes of external memory space, this address space can be restricted to 1 MByte, 256 KByte or to 64 KByte. In this case Port 4 outputs four, two or no address lines at all. It outputs all 8 address lines, if an address space of 16 MBytes is used.

Central Processing Unit (CPU)

The main core of the CPU consists of a 4-stage instruction pipeline, a 16-bit arithmetic and logic unit (ALU) and dedicated SFRs. Additional hardware has been spent for a separate multiply and divide unit, a bit-mask generator and a barrel shifter.

Based on these hardware provisions, most of the C167CR's instructions can be executed in just one machine cycle which requires 100 ns at 20-MHz CPU clock. For example, shift and rotate instructions are always processed during one machine cycle independent of the number of bits to be shifted. All multiple-cycle instructions have been optimized so that they can be executed very fast as well: branches in 2 cycles, a 16 × 16 bit multiplication in 5 cycles and a 32-/16 bit division in 10 cycles. Another pipeline optimization, the so-called 'Jump Cache', allows reducing the execution time of repeatedly performed jumps in a loop from 2 cycles to 1 cycle.

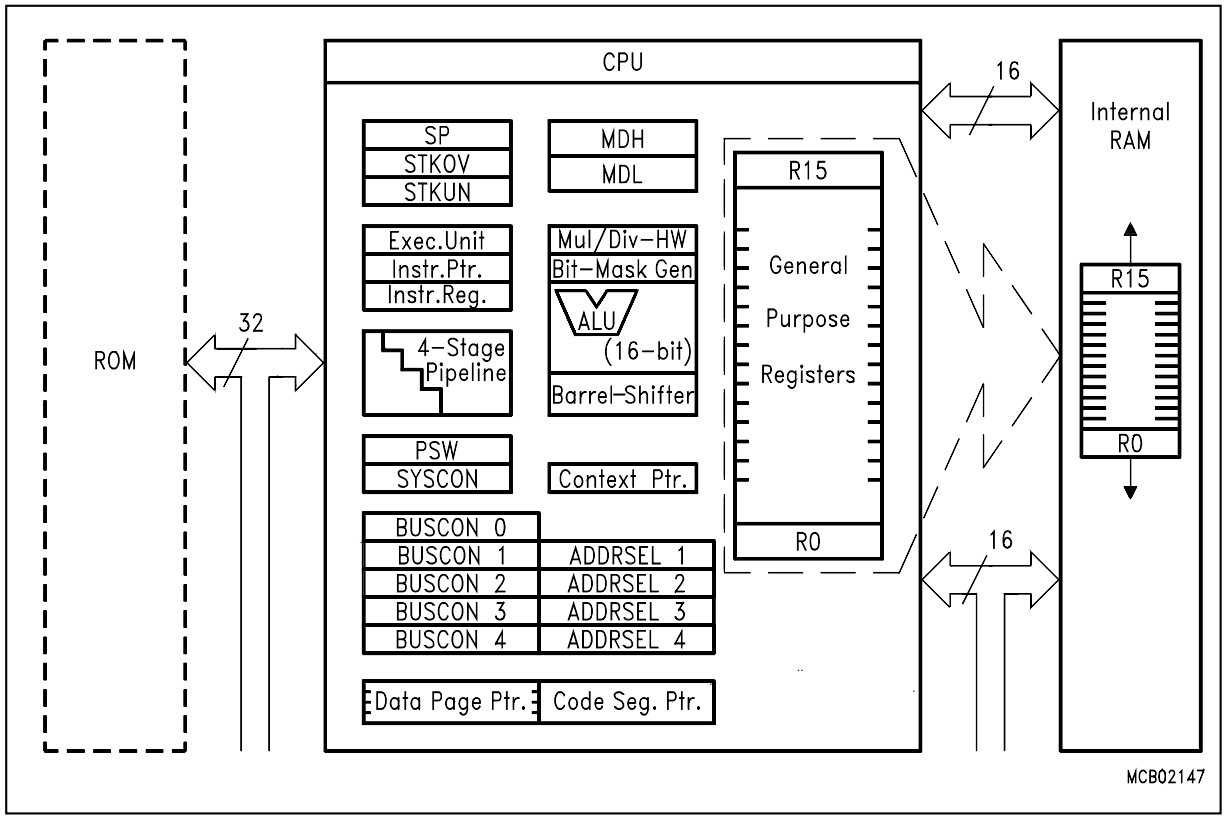


Figure 4
CPU Block Diagram

The CPU disposes of an actual register context consisting of up to 16 wordwide GPRs which are physically allocated within the on-chip RAM area. A Context Pointer (CP) register determines the base address of the active register bank to be accessed by the CPU at a time. The number of register banks is only restricted by the available internal RAM space. For easy parameter passing, a register bank may overlap others.

A system stack of up to 2048 bytes is provided as a storage for temporary data. The system stack is allocated in the on-chip RAM area, and it is accessed by the CPU via the stack pointer (SP) register. Two separate SFRs, STKOV and STKUN, are implicitly compared against the stack pointer value upon each stack access for the detection of a stack overflow or underflow.

The high performance offered by the hardware implementation of the CPU can efficiently be utilized by a programmer via the highly efficient C167CR instruction set which includes the following instruction classes:

– Arithmetic Instructions
– Logical Instructions
– Boolean Bit Manipulation Instructions
– Compare and Loop Control Instructions
– Shift and Rotate Instructions
– Prioritize Instruction
– Data Movement Instructions
– System Stack Instructions
– Jump and Call Instructions
– Return Instructions
– System Control Instructions
– Miscellaneous Instructions

The basic instruction length is either 2 or 4 bytes. Possible operand types are bits, bytes and words. A variety of direct, indirect or immediate addressing modes are provided to specify the required operands.

Interrupt System

With an interrupt response time within a range from just 250 ns to 600 ns (in case of internal program execution), the C167CR is capable of reacting very fast to the occurrence of non-deterministic events.

The architecture of the C167CR supports several mechanisms for fast and flexible response to service requests that can be generated from various sources internal or external to the microcontroller. Any of these interrupt requests can be programmed to being serviced by the Interrupt Controller or by the Peripheral Event Controller (PEC).

In contrast to a standard interrupt service where the current program execution is suspended and a branch to the interrupt vector table is performed, just one cycle is ‘stolen’ from the current CPU activity to perform a PEC service. A PEC service implies a single byte or word data transfer between any two memory locations with an additional increment of either the PEC source or the destination pointer. An individual PEC transfer counter is implicity decremented for each PEC service except when performing in the continuous transfer mode. When this counter reaches zero, a standard interrupt is performed to the corresponding source related vector location. PEC services are very well suited, for example, for supporting the transmission or reception of blocks of data. The C167CR has 8 PEC channels each of which offers such fast interrupt-driven data transfer capabilities.

A separate control register which contains an interrupt request flag, an interrupt enable flag and an interrupt priority bitfield exists for each of the possible interrupt sources. Via its related register, each source can be programmed to one of sixteen interrupt priority levels. Once having been accepted by the CPU, an interrupt service can only be interrupted by a higher prioritized service request. For the standard interrupt processing, each of the possible interrupt sources has a dedicated vector location.

Fast external interrupt inputs are provided to service external interrupts with high precision requirements. These fast interrupt inputs feature programmable edge detection (rising edge, falling edge or both edges).

Software interrupts are supported by means of the ‘TRAP’ instruction in combination with an individual trap (interrupt) number.

The following table shows all of the possible C167CR interrupt sources and the corresponding hardware-related interrupt flags, vectors, vector locations and trap (interrupt) numbers:

Note: Three nodes in the table (X-Peripheral nodes) are prepared to accept interrupt requests from integrated X-Bus peripherals. Nodes, where no X-Peripherals are connected, may be used to generate software controlled interrupt requests by setting the respective XPnIR bit.

Source of Interrupt or PEC Service Request	Request Flag	Enable Flag	Interrupt Vector	Vector Location	Trap Number
CAPCOM Register 0	CC0IR	CC0IE	CC0INT	$00'0040_H$	10_H
CAPCOM Register 1	CC1IR	CC1IE	CC1INT	$00'0044_H$	11_H
CAPCOM Register 2	CC2IR	CC2IE	CC2INT	$00'0048_H$	12_H
CAPCOM Register 3	CC3IR	CC3IE	CC3INT	$00'004C_H$	13_H
CAPCOM Register 4	CC4IR	CC4IE	CC4INT	$00'0050_H$	14_H
CAPCOM Register 5	CC5IR	CC5IE	CC5INT	$00'0054_H$	15_H
CAPCOM Register 6	CC6IR	CC6IE	CC6INT	$00'0058_H$	16_H
CAPCOM Register 7	CC7IR	CC7IE	CC7INT	$00'005C_H$	17_H
CAPCOM Register 8	CC8IR	CC8IE	CC8INT	$00'0060_H$	18_H
CAPCOM Register 9	CC9IR	CC9IE	CC9INT	$00'0064_H$	19_H
CAPCOM Register 10	CC10IR	CC10IE	CC10INT	$00'0068_H$	$1A_H$
CAPCOM Register 11	CC11IR	CC11IE	CC11INT	$00'006C_H$	$1B_H$
CAPCOM Register 12	CC12IR	CC12IE	CC12INT	$00'0070_H$	$1C_H$
CAPCOM Register 13	CC13IR	CC13IE	CC13INT	$00'0074_H$	$1D_H$
CAPCOM Register 14	CC14IR	CC14IE	CC14INT	$00'0078_H$	$1E_H$
CAPCOM Register 15	CC15IR	CC15IE	CC15INT	$00'007C_H$	$1F_H$
CAPCOM Register 16	CC16IR	CC16IE	CC16INT	$00'00C0_H$	30_H
CAPCOM Register 17	CC17IR	CC17IE	CC17INT	$00'00C4_H$	31_H
CAPCOM Register 18	CC18IR	CC18IE	CC18INT	$00'00C8_H$	32_H
CAPCOM Register 19	CC19IR	CC19IE	CC19INT	$00'00CC_H$	33_H
CAPCOM Register 20	CC20IR	CC20IE	CC20INT	$00'00D0_H$	34_H
CAPCOM Register 21	CC21IR	CC21IE	CC21INT	$00'00D4_H$	35_H
CAPCOM Register 22	CC22IR	CC22IE	CC22INT	$00'00D8_H$	36_H
CAPCOM Register 23	CC23IR	CC23IE	CC23INT	$00'00DC_H$	37_H
CAPCOM Register 24	CC24IR	CC24IE	CC24INT	$00'00E0_H$	38_H
CAPCOM Register 25	CC25IR	CC25IE	CC25INT	$00'00E4_H$	39_H
CAPCOM Register 26	CC26IR	CC26IE	CC26INT	$00'00E8_H$	$3A_H$
CAPCOM Register 27	CC27IR	CC27IE	CC27INT	$00'00EC_H$	$3B_H$
CAPCOM Register 28	CC28IR	CC28IE	CC28INT	$00'00E0_H$	$3C_H$
CAPCOM Register 29	CC29IR	CC29IE	CC29INT	$00'0110_H$	44_H
CAPCOM Register 30	CC30IR	CC30IE	CC30INT	$00'0114_H$	45_H
CAPCOM Register 31	CC31IR	CC31IE	CC31INT	$00'0118_H$	46_H
CAPCOM Timer 0	T0IR	T0IE	T0INT	$00'0080_H$	20_H

Source of Interrupt or PEC Service Request	Request Flag	Enable Flag	Interrupt Vector	Vector Location	Trap Number
CAPCOM Timer 1	T1IR	T1IE	T1INT	$00'0084_H$	21_H
CAPCOM Timer 7	T7IR	T7IE	T7INT	$00'00F4_H$	$3D_H$
CAPCOM Timer 8	T8IR	T8IE	T8INT	$00'00F8_H$	$3E_H$
GPT1 Timer 2	T2IR	T2IE	T2INT	$00'0088_H$	22_H
GPT1 Timer 3	T3IR	T3IE	T3INT	$00'008C_H$	23_H
GPT1 Timer 4	T4IR	T4IE	T4INT	$00'0090_H$	24_H
GPT2 Timer 5	T5IR	T5IE	T5INT	$00'0094_H$	25_H
GPT2 Timer 6	T6IR	T6IE	T6INT	$00'0098_H$	26_H
GPT2 CAPREL Register	CRIR	CRIE	CRINT	$00'009C_H$	27_H
A/D Conversion Complete	ADCIR	ADCIE	ADCINT	$00'00A0_H$	28_H
A/D Overrun Error	ADEIR	ADEIE	ADEINT	$00'00A4_H$	29_H
ASC0 Transmit	S0TIR	S0TIE	S0TINT	$00'00A8_H$	$2A_H$
ASC0 Transmit Buffer	S0TBIR	S0TBIE	S0TBINT	$00'011C_H$	47_H
ASC0 Receive	S0RIR	S0RIE	S0RINT	$00'00AC_H$	$2B_H$
ASC0 Error	S0EIR	S0EIE	S0EINT	$00'00B0_H$	$2C_H$
SSC Transmit	SCTIR	SCTIE	SCTINT	$00'00B4_H$	$2D_H$
SSC Receive	SCRIR	SCRIE	SCRINT	$00'00B8_H$	$2E_H$
SSC Error	SCEIR	SCEIE	SCEINT	$00'00BC_H$	$2F_H$
PWM Channel 0...3	PWMIR	PWMIE	PWMINT	$00'00FC_H$	$3F_H$
CAN Interface	XP0IR	XP0IE	XP0INT	$00'0100_H$	40_H
X-Peripheral Node	XP1IR	XP1IE	XP1INT	$00'0104_H$	41_H
X-Peripheral Node	XP2IR	XP2IE	XP2INT	$00'0108_H$	42_H
PLL Unlock	XP3IR	XP3IE	XP3INT	$00'010C_H$	43_H

The C167CR also provides an excellent mechanism to identify and to process exceptions or error conditions that arise during run-time, so-called ‘Hardware Traps’. Hardware traps cause immediate non-maskable system reaction which is similar to a standard interrupt service (branching to a dedicated vector table location). The occurrence of a hardware trap is additionally signified by an individual bit in the trap flag register (TFR). Except when another higher prioritized trap service is in progress, a hardware trap will interrupt any actual program execution. In turn, hardware trap services can normally not be interrupted by standard or PEC interrupts.

The following table shows all of the possible exceptions or error conditions that can arise during run-time:

Exception Condition	Trap Flag	Trap Vector	Vector Location	Trap Number	Trap Priority
Reset Functions:					
Hardware Reset		RESET	$00'0000_H$	00_H	III
Software Reset		RESET	$00'0000_H$	00_H	III
Watchdog Timer Overflow		RESET	$00'0000_H$	00_H	III
Class A Hardware Traps:					
Non-Maskable Interrupt	NMI	NMITRAP	$00'0008_H$	02_H	II
Stack Overflow	STKOF	STOTRAP	$00'0010_H$	04_H	II
Stack Underflow	STKUF	STUTRAP	$00'0018_H$	06_H	II
Class B Hardware Traps:					
Undefined Opcode	UNDOPC	BTRAP	$00'0028_H$	$0A_H$	I
Protected Instruction Fault	PRTFLT	BTRAP	$00'0028_H$	$0A_H$	I
Illegal Word Operand Access	ILLOPA	BTRAP	$00'0028_H$	$0A_H$	I
Illegal Instruction Access	ILLINA	BTRAP	$00'0028_H$	$0A_H$	I
Illegal External Bus Access	ILLBUS	BTRAP	$00'0028_H$	$0A_H$	I
Reserved			$[2C_H – 3C_H]$	$[0B_H – 0F_H]$	
Software Traps TRAP Instruction			Any $[00'0000_H – 00'01FC_H]$ in steps of 4_H	Any $[00_H – 7F_H]$	Current CPU Priority

Capture/Compare (CAPCOM) Units

The CAPCOM units support generation and control of timing sequences on up to 32 channels with a maximum resolution of 400 ns (at 20-MHz system clock). The CAPCOM units are typically used to handle high speed I/O tasks such as pulse and waveform generation, pulse width modulation (PMW), Digital to Analog (D/A) conversion, software timing, or time recording relative to external events.

Four 16-bit timers (T0/T1, T7/T8) with reload registers provide two independent time bases for the capture/compare register array.

The input clock for the timers is programmable to several prescaled values of the internal system clock, or may be derived from an overflow/underflow of timer T6 in module GPT2. This provides a wide range of variation for the timer period and resolution and allows precise adjustments to the application specific requirements. In addition, external count inputs for CAPCOM timers T0 and T7 allow event scheduling for the capture/compare registers relative to external events.

Both of the two capture/compare register arrays contain 16 dual purpose capture/compare registers, each of which may be individually allocated to either CAPCOM timer T0 or T1 (T7 or T8, respectively), and programmed for capture or compare function. Each register has one port pin associated with it which serves as an input pin for triggering the capture function, or as an output pin (except for CC24...CC27) to indicate the occurrence of a compare event.

When a capture/compare register has been selected for capture mode, the current contents of the allocated timer will be latched (‘capture’d) into the capture/compare register in response to an external event at the port pin which is associated with this register. In addition, a specific interrupt request for this capture/compare register is generated. Either a positive, a negative, or both a positive and a negative external signal transition at the pin can be selected as the triggering event. The contents of all registers which have been selected for one of the five compare modes are continuously compared with the contents of the allocated timers. When a match occurs between the timer value and the value in a capture/compare register, specific actions will be taken based on the selected compare mode.

Compare Modes	Function
Mode 0	Interrupt-only compare mode; several compare interrupts per timer period are possible
Mode 1	Pin toggles on each compare match; several compare events per timer period are possible
Mode 2	Interrupt-only compare mode; only one compare interrupt per timer period is generated
Mode 3	Pin set ‘1’ on match; pin reset ‘0’ on compare time overflow; only one compare event per timer period is generated
Double Register Mode	Two registers operate on one pin; pin toggles on each compare match; several compare events per timer period are possible.

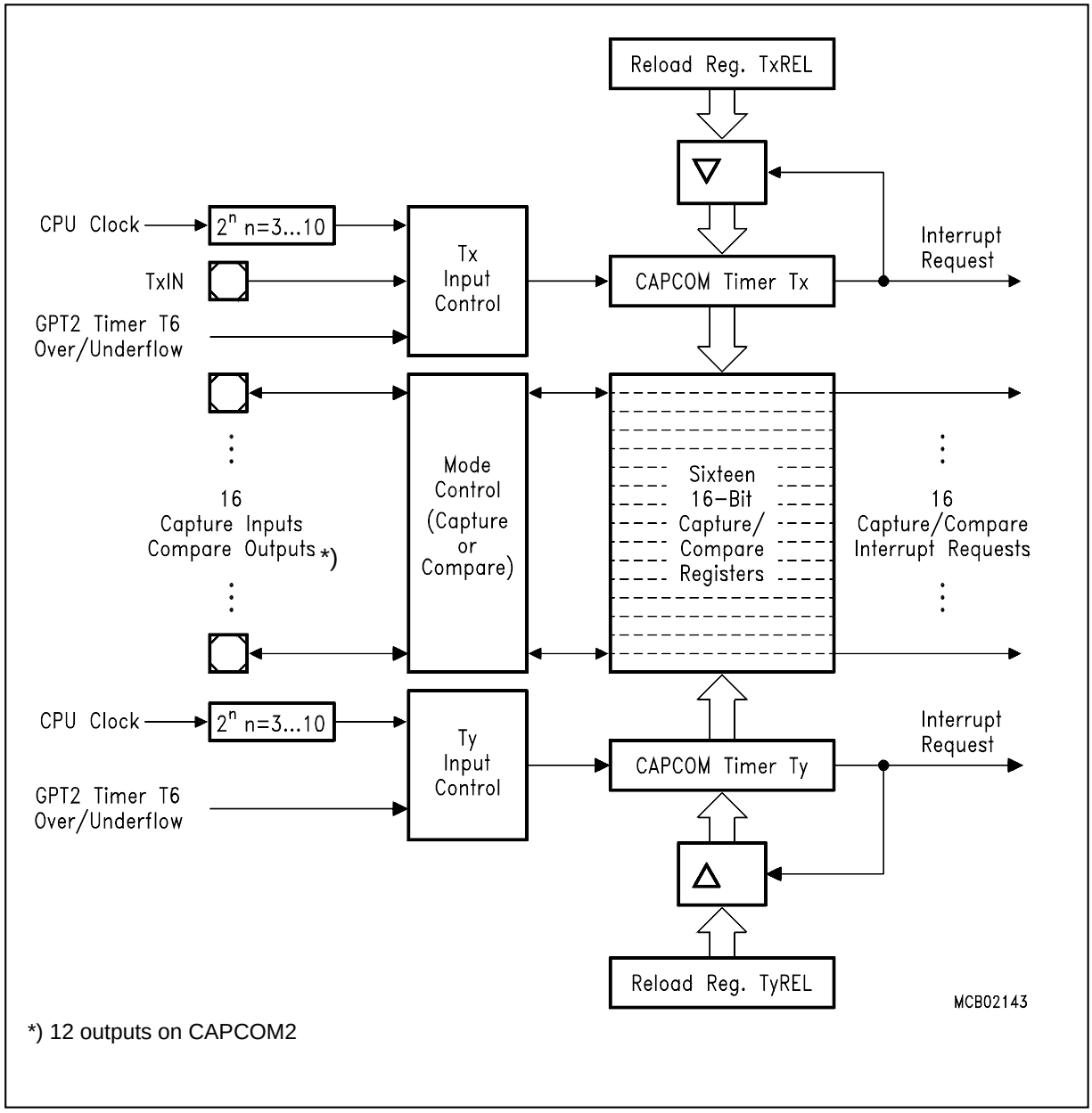


Figure 5
CAPCOM Unit Block Diagram

PWM Module

The Pulse Width Modulation Module can generate up to four PWM output signals using edge-aligned or center-aligned PWM. In addition the PWM module can generate PWM burst signals and single shot outputs. The frequency range of the PWM signals covers 4.8 Hz to 1 MHz (referred to a CPU clock of 20 MHz), depending on the resolution of the PWM output signal. The level of the output signals is selectable and the PWM module can generate interrupt requests.

General Purpose Timer (GPT) Unit

The GPT unit represents a very flexible multifunctional timer/counter structure which may be used for many different time related tasks such as event timing and counting, pulse width and duty cycle measurements, pulse generation, or pulse multiplication.

The GPT unit incorporates five 16-bit timers which are organized in two separate modules, GPT1 and GPT2. Each timer in each module may operate independently in a number of different modes, or may be concatenated with another timer of the same module.

Each of the three timers T2, T3, T4 of module GPT1 can be configured individually for one of three basic modes of operation, which are Timer, Gated Timer, and Counter Mode. In Timer Mode, the input clock for a timer is derived from the CPU clock, divided by a programmable prescaler, while Counter Mode allows a timer to be clocked in reference to external events.
Pulse width or duty cycle measurement is supported in Gated Timer Mode, where the operation of a timer is controlled by the ‘gate’ level on an external input pin. For these purposes, each timer has one associated port pin (TxIN) which serves as gate or clock input. The maximum resolution of the timers in module GPT1 is 400 ns (@ 20-MHz CPU clock).

The count direction (up/down) for each timer is programmable by software or may additionally be altered dynamically by an external signal on a port pin (TxEUD) to facilitate e. g. position tracking.

Timers T3 and T4 have output toggle latches (TxOTL) which change their state on each timer over-flow/underflow. The state of these latches may be output on port pins (TxOUT) e. g. for time out monitoring of external hardware components, or may be used internally to clock timers T2 and T4 for measuring long time periods with high resolution.

In addition to their basic operating modes, timers T2 and T4 may be configured as reload or capture registers for timer T3. When used as capture or reload registers, timers T2 and T4 are stopped. The contents of timer T3 is captured into T2 or T4 in response to a signal at their associated input pins (TxIN). Timer T3 is reloaded with the contents of T2 or T4 triggered either by an external signal or by a selectable state transition of its toggle latch T3OTL. When both T2 and T4 are configured to alternately reload T3 on opposite state transitions of T3OTL with the low and high times of a PWM signal, this signal can be constantly generated without software intervention.

With its maximum resolution of 200 ns (@ 20 MHz), the GPT2 module provides precise event control and time measurement. It includes two timers (T5, T6) and a capture/reload register (CAPREL). Both timers can be clocked with an input clock which is derived from the CPU clock via a programmable prescaler or with external signals. The count direction (up/down) for each timer is programmable by software or may additionally be altered dynamically by an external signal on a port pin (TxEUD). Concatenation of the timers is supported via the output toggle latch (T6OTL) of timer T6, which changes its state on each timer overflow/underflow.

The state of this latch may be used to clock timer T5, or it may be output on a port pin (T6OUT). The overflows/underflows of timer T6 can additionally be used to clock the CAPCOM timers T0 or T1, and to cause a reload from the CAPREL register. The CAPREL register may capture the contents of timer T5 based on an external signal transition on the corresponding port pin (CAPIN), and timer T5 may optionally be cleared after the capture procedure. This allows absolute time differences to be measured or pulse multiplication to be performed without software overhead.

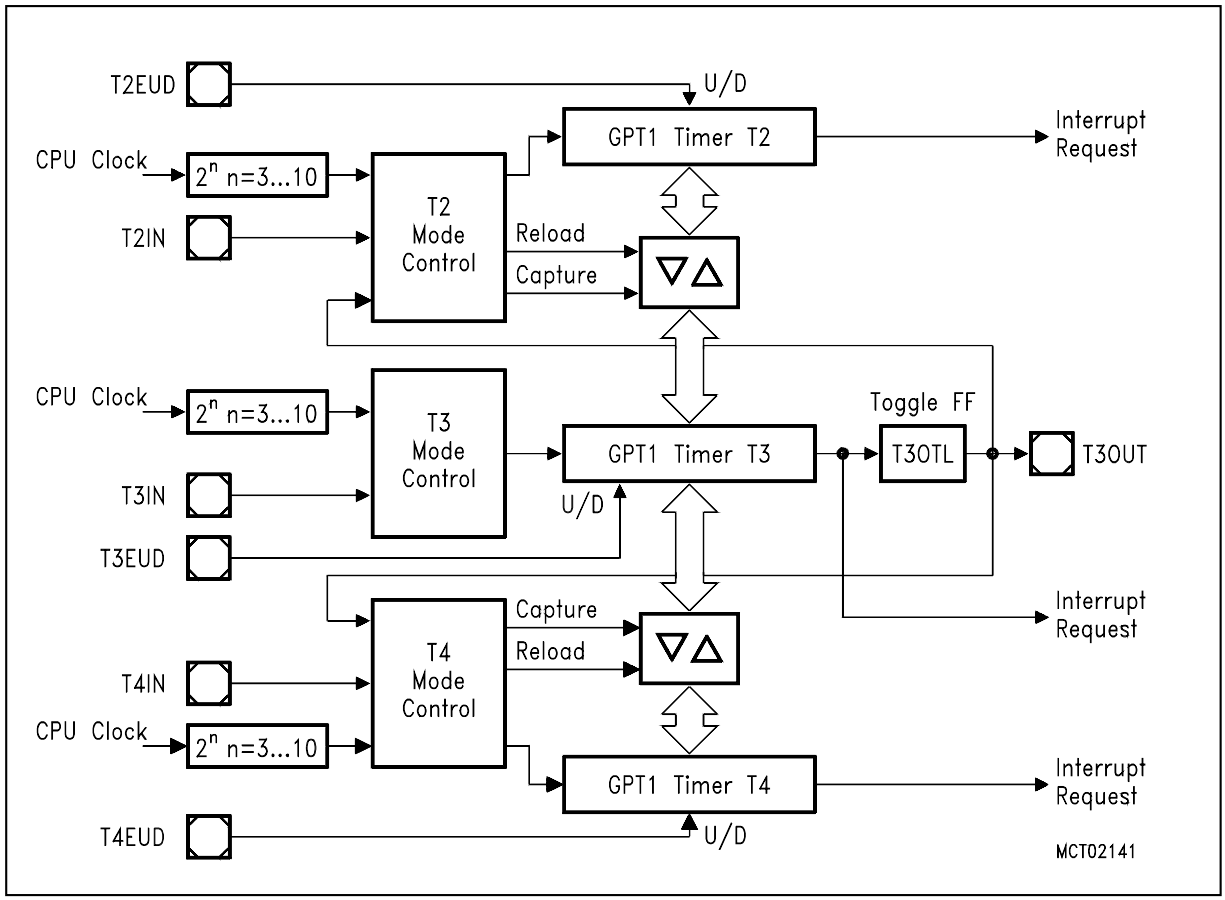


Figure 6
Block Diagram of GPT1

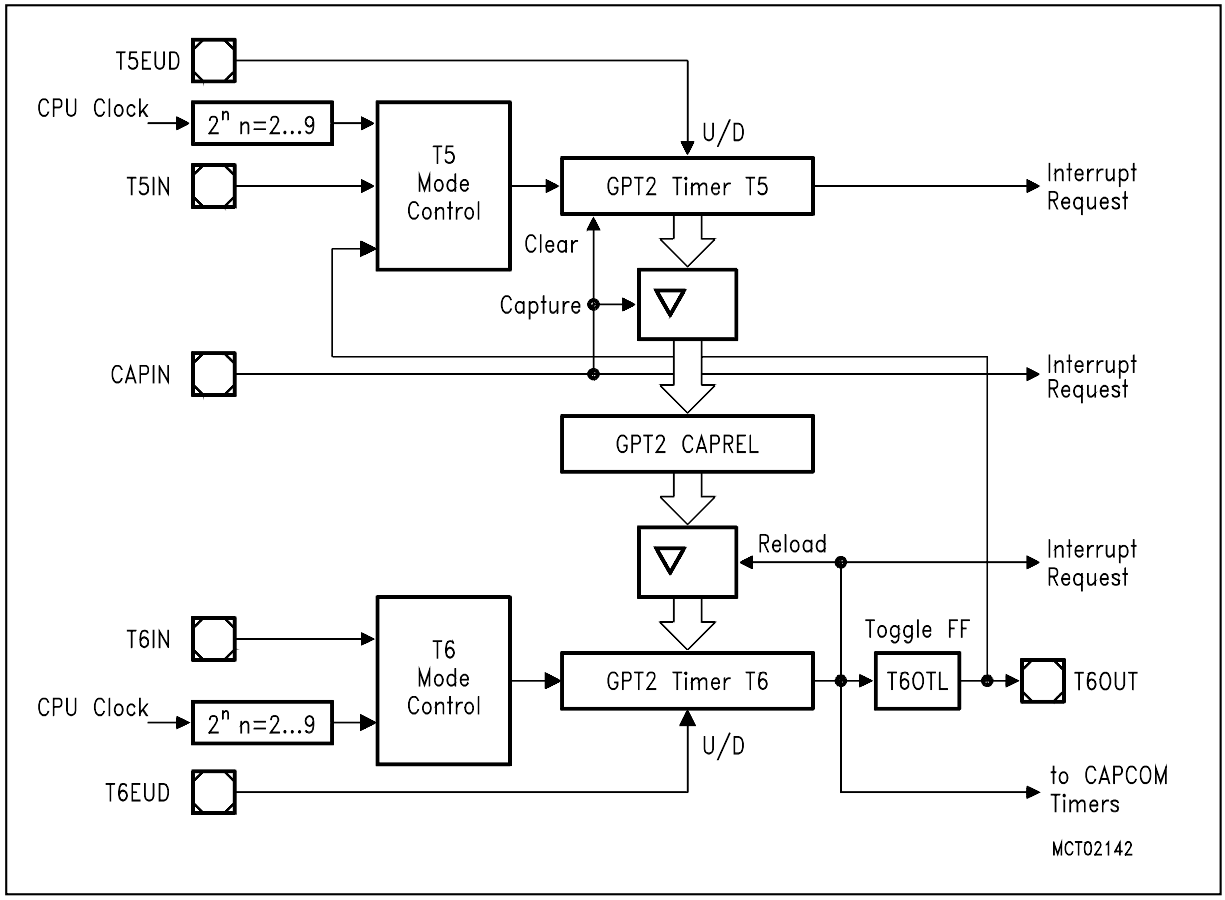


Figure 7
Block Diagram of GPT2

Watchdog Timer

The Watchdog Timer represents one of the fail-safe mechanisms which have been implemented to prevent the controller from malfunctioning for longer periods of time.

The Watchdog Timer is always enabled after a reset of the chip, and can only be disabled in the time interval until the EINIT (end of initialization) instruction has been executed. Thus, the chip's start-up procedure is always monitored. The software has to be designed to service the Watchdog Timer before it overflows. If, due to hardware or software related failures, the software fails to do so, the Watchdog Timer overflows and generates an internal hardware reset and pulls the $\overline{\text{RSTOUT}}$ pin low in order to allow external hardware components to be reset.

The Watchdog Timer is a 16-bit timer, clocked with the system clock divided either by 2 or by 128. The high byte of the Watchdog Timer register can be set to a prespecified reload value (stored in WDTREL) in order to allow further variation of the monitored time interval. Each time it is serviced by the application software, the high byte of the Watchdog Timer is reloaded. Thus, time intervals between 25 µs and 420 ms can be monitored (@ 20 MHz). The default Watchdog Timer interval after reset is 6.55 ms (@ 20 MHz).

A/D Converter

For analog signal measurement, a 10-bit A/D converter with 16 multiplexed input channels and a sample and hold circuit has been integrated on-chip. It uses the method of successive approximation. The sample time (for loading the capacitors) and the conversion time is programmable and can so be adjusted to the external circuitry.

Overrun error detection/protection is provided for the conversion result register (ADDAT): either an interrupt request will be generated when the result of a previous conversion has not been read from the result register at the time the next conversion is complete, or the next conversion is suspended in such a case until the previous result has been read.

For applications which require less than 16 analog input channels, the remaining channel inputs can be used as digital input port pins.

The A/D converter of the C167CR supports four different conversion modes. In the standard Single Channel conversion mode, the analog level on a specified channel is sampled once and converted to a digital result. In the Single Channel Continuous mode, the analog level on a specified channel is repeatedly sampled and converted without software intervention. In the Auto Scan mode, the analog levels on a prespecified number of channels are sequentially sampled and converted. In the Auto Scan Continuous mode, the number of prespecified channels is repeatedly sampled and converted. In addition, the conversion of a specific channel can be inserted (injected) into a running sequence without disturbing this sequence. This is called Channel Injection Mode.

The Peripheral Event Controller (PEC) may be used to automatically store the conversion results into a table in memory for later evaluation, without requiring the overhead of entering and exiting interrupt routines for each data transfer.

After each reset and also during normal operation the ADC automatically performs calibration cycles. This automatic self-calibration constantly adjusts the converter to changing operating conditions (e.g. temperature) and compensates process variations.

These calibration cycles are part of the conversion cycle, so they do not affect the normal operation of the A/D converter.

Serial Channels

Serial communication with other microcontrollers, processors, terminals or external peripheral components is provided by two serial interfaces with different functionality, an Asynchronous/ Synchronous Serial Channel (ASC0) and a High-Speed Synchronous Serial Channel (SSC).

ASC0 is upward compatible with the serial ports of the Siemens SAB 8051x microcontroller family and support full-duplex asynchronous communication up to 625 KBaud and half-duplex synchronous communication up to 2.5 Mbaud on the @ 20-MHz system clock.
The SSC allows half duplex synchronous communication up to 5 Mbaud @ 20-MHz system clock.

Two dedicated baud rate generators allow to set up all standard baud rates without oscillator tuning. For transmission, reception, and erroneous reception 3 separate interrupt vectors are provided for each serial channel.

In asynchronous mode, 8- or 9-bit data frames are transmitted or received, preceded by a start bit and terminated by one or two stop bits. For multiprocessor communication, a mechanism to distinguish address from data bytes has been included (8-bit data + wake up bit mode).
In synchronous mode, the ASC0 transmits or receives bytes (8 bits) synchronously to a shift clock which is generated by the ASC0. The SSC transmits or receives characters of 2...16 bits length synchronously to a shift clock which can be generated by the SSC (master mode) or by an external master (slave mode). The SSC can start shifting with the LSB or with the MSB, while the ASC0 always shifts the LSB first.
A loop back option is available for testing purposes.

A number of optional hardware error detection capabilities has been included to increase the reliability of data transfers. A parity bit can automatically be generated on transmission or be checked on reception. Framing error detection allows to recognize data frames with missing stop bits. An overrun error will be generated, if the last character received has not been read out of the receive buffer register at the time the reception of a new character is complete.

CAN-Module

The integrated CAN-Module handles the completely autonomous transmission and reception of CAN frames in accordance with the CAN specification V2.0 part B (active), i.e. the on-chip CAN-Module can receive and transmit standard frames with 11-bit identifiers as well as extended frames with 29-bit identifiers.

The module provides Full CAN functionality on up to 15 message objects. Message object 15 may be configured for Basic CAN functionality. Both modes provide separate masks for acceptance filtering which allows to accept a number of identifiers in Full CAN mode and also allows to disregard a number of identifiers in Basic CAN mode. All message objects can be updated independent from the other objects and are equipped for the maximum message length of 8 bytes.

The bit timing is derived from the XCLK and is programmable up to a data rate of 1 MBaud. The CAN-Module uses two pins to interface to a bus transceiver.

Parallel Ports

The C167CR provides up to 111 I/O lines which are organized into eight input/output ports and one input port. All port lines are bit-addressable, and all input/output lines are individually (bit-wise) programmable as inputs or outputs via direction registers. The I/O ports are true bidirectional ports which are switched to high impedance state when configured as inputs. The output drivers of five I/O ports can be configured (pin by pin) for push/pull operation or open-drain operation via control registers. During the internal reset, all port pins are configured as inputs.

The input threshold of Port 2, Port 3, Port 7 and Port 8 is selectable (TTL or CMOS like), where the special CMOS like input threshold reduces noise sensitivity due to the input hysteresis. The input threshold may be selected individually for each byte of the respective ports.

All port lines have programmable alternate input or output functions associated with them.
PORT0 and PORT1 may be used as address and data lines when accessing external memory, while Port 4 outputs the additional segment address bits A23/19/17...A16 in systems where segmentation is enabled to access more than 64 KBytes of memory.

Port 2, Port 8 and Port 7 are associated with the capture inputs or compare outputs of the CAPCOM units and/or with the outputs of the PWM module.
Port 6 provides optional bus arbitration signals ($\overline{\text{BREQ}}$, $\overline{\text{HLDA}}$, $\overline{\text{HOLD}}$) and chip select signals.
Port 3 includes alternate functions of timers, serial interfaces, the optional bus control signal $\overline{\text{BHE}}$ and the system clock output (CLKOUT).
Port 5 is used for the analog input channels to the A/D converter or timer control signals.

All port lines that are not used for these alternate functions may be used as general purpose IO lines.

Instruction Set Summary

The table below lists the instructions of the C167CR in a condensed way.
The various addressing modes that can be used with a specific instruction, the operation of the instructions, parameters for conditional execution of instructions, and the opcodes for each instruction can be found in the **"C16x Family Instruction Set Manual"**.

This document also provides a detailed description of each instruction.

Instruction Set Summary

Mnemonic	Description	Bytes
ADD(B)	Add word (byte) operands	2 / 4
ADDC(B)	Add word (byte) operands with Carry	2 / 4
SUB(B)	Subtract word (byte) operands	2 / 4
SUBC(B)	Subtract word (byte) operands with Carry	2 / 4
MUL(U)	(Un)Signed multiply direct GPR by direct GPR (16-16-bit)	2
DIV(U)	(Un)Signed divide register MDL by direct GPR (16-/16-bit)	2
DIVL(U)	(Un)Signed long divide reg. MD by direct GPR (32-/16-bit)	2
CPL(B)	Complement direct word (byte) GPR	2
NEG(B)	Negate direct word (byte) GPR	2
AND(B)	Bitwise AND, (word/byte operands)	2 / 4
OR(B)	Bitwise OR, (word/byte operands)	2 / 4
XOR(B)	Bitwise XOR, (word/byte operands)	2 / 4
BCLR	Clear direct bit	2
BSET	Set direct bit	2
BMOV(N)	Move (negated) direct bit to direct bit	4
BAND, BOR, BXOR	AND/OR/XOR direct bit with direct bit	4
BCMP	Compare direct bit to direct bit	4
BFLDH/L	Bitwise modify masked high/low byte of bit-addressable direct word memory with immediate data	4
CMP(B)	Compare word (byte) operands	2 / 4
CMPD1/2	Compare word data to GPR and decrement GPR by 1/2	2 / 4
CMPI1/2	Compare word data to GPR and increment GPR by 1/2	2 / 4
PRIOR	Determine number of shift cycles to normalize direct word GPR and store result in direct word GPR	2
SHL / SHR	Shift left/right direct word GPR	2
ROL / ROR	Rotate left/right direct word GPR	2
ASHR	Arithmetic (sign bit) shift right direct word GPR	2

Instruction Set Summary (cont'd)

Mnemonic	Description	Bytes
MOV(B)	Move word (byte) data	2 / 4
MOVBS	Move byte operand to word operand with sign extension	2 / 4
MOVBZ	Move byte operand to word operand. with zero extension	2 / 4
JMPA, JMPI, JMPR	Jump absolute/indirect/relative if condition is met	4
JMPS	Jump absolute to a code segment	4
J(N)B	Jump relative if direct bit is (not) set	4
JBC	Jump relative and clear bit if direct bit is set	4
JNBS	Jump relative and set bit if direct bit is not set	4
CALLA, CALLI, CALLR	Call absolute/indirect/relative subroutine if condition is met	4
CALLS	Call absolute subroutine in any code segment	4
PCALL	Push direct word register onto system stack and call absolute subroutine	4
TRAP	Call interrupt service routine via immediate trap number	2
PUSH, POP	Push/pop direct word register onto/from system stack	2
SCXT	Push direct word register onto system stack and update register with word operand	4
RET	Return from intra-segment subroutine	2
RETS	Return from inter-segment subroutine	2
RETP	Return from intra-segment subroutine and pop direct word register from system stack	2
RETI	Return from interrupt service subroutine	2
SRST	Software Reset	4
IDLE	Enter Idle Mode	4
PWRDN	Enter Power Down Mode (supposes $\overline{\text{NMI}}$-pin being low)	4
SRVWDT	Service Watchdog Timer	4
DISWDT	Disable Watchdog Timer	4
EINIT	Signify End-of-Initialization on RSTOUT-pin	4
ATOMIC	Begin ATOMIC sequence	2
EXTR	Begin EXTended Register sequence	2
EXTP(R)	Begin EXTended Page (and Register) sequence	2 / 4
EXTS(R)	Begin EXTended Segment (and Register) sequence	2 / 4
NOP	Null operation	2

Special Function Registers Overview

The following table lists all SFRs which are implemented in the C167CR in alphabetical order. **Bit-addressable** SFRs are marked with the letter "**b**" in column "Name". SFRs within the **Extended SFR-Space** (ESFRs) are marked with the letter "**E**" in column "Physical Address".

An SFR can be specified via its individual mnemonic name. Depending on the selected addressing mode, an SFR can be accessed via its physical address (using the Data Page Pointers), or via its short 8-bit address (without using the Data Page Pointers).

Special Function Registers Overview

Name	Physical Address	8-Bit Address	Description	Reset Value
ADCIC b	$FF98_H$	CC_H	A/D Converter End of Conversion Interrupt Control Register	0000_H
ADCON b	$FFA0_H$	$D0_H$	A/D Converter Control Register	0000_H
ADDAT	$FEA0_H$	50_H	A/D Converter Result Register	0000_H
ADDAT2	$F0A0_H$ **E**	50_H	A/D Converter 2 Result Register	0000_H
ADDRSEL1	$FE18_H$	$0C_H$	Address Select Register 1	0000_H
ADDRSEL2	$FE1A_H$	$0D_H$	Address Select Register 2	0000_H
ADDRSEL3	$FE1C_H$	$0E_H$	Address Select Register 3	0000_H
ADDRSEL4	$FE1E_H$	$0F_H$	Address Select Register 4	0000_H
ADEIC b	$FF9A_H$	CD_H	A/D Converter Overrun Error Interrupt Control Register	0000_H
BUSCON0 b	$FF0C_H$	86_H	Bus Configuration Register 0	$0XX0_H$
BUSCON1 b	$FF14_H$	$8A_H$	Bus Configuration Register 1	0000_H
BUSCON2 b	$FF16_H$	$8B_H$	Bus Configuration Register 2	0000_H
BUSCON3 b	$FF18_H$	$8C_H$	Bus Configuration Register 3	0000_H
BUSCON4 b	$FF1A_H$	$8D_H$	Bus Configuration Register 4	0000_H
CAPREL	$FE4A_H$	25_H	GPT2 Capture/Reload Register	0000_H
CC0	$FE80_H$	40_H	CAPCOM Register 0	0000_H
CC0IC b	$FF78_H$	BC_H	CAPCOM Register 0 Interrupt Control Register	0000_H
CC1	$FE82_H$	41_H	CAPCOM Register 1	0000_H
CC1IC b	$FF7A_H$	BD_H	CAPCOM Register 1 Interrupt Control Register	0000_H
CC2	$FE84_H$	42_H	CAPCOM Register 2	0000_H
CC2IC b	$FF7C_H$	BE_H	CAPCOM Register 2 Interrupt Control Register	0000_H

Special Function Registers Overview (cont'd)

Name		Physical Address	8-Bit Address	Description	Reset Value
CC3		$FE86_H$	43_H	CAPCOM Register 3	0000_H
CC3IC	**b**	$FF7E_H$	BF_H	CAPCOM Register 3 Interrupt Control Register	0000_H
CC4		$FE88_H$	44_H	CAPCOM Register 4	0000_H
CC4IC	**b**	$FF80_H$	$C0_H$	CAPCOM Register 4 Interrupt Control Register	0000_H
CC5		$FE8A_H$	45_H	CAPCOM Register 5	0000_H
CC5IC	**b**	$FF82_H$	$C1_H$	CAPCOM Register 5 Interrupt Control Register	0000_H
CC6		$FE8C_H$	46_H	CAPCOM Register 6	0000_H
CC6IC	**b**	$FF84_H$	$C2_H$	CAPCOM Register 6 Interrupt Control Register	0000_H
CC7		$FE8E_H$	47_H	CAPCOM Register 7	0000_H
CC7IC	**b**	$FF86_H$	$C3_H$	CAPCOM Register 7 Interrupt Control Register	0000_H
CC8		$FE90_H$	48_H	CAPCOM Register 8	0000_H
CC8IC	**b**	$FF88_H$	$C4_H$	CAPCOM Register 8 Interrupt Control Register	0000_H
CC9		$FE92_H$	49_H	CAPCOM Register 9	0000_H
CC9IC	**b**	$FF8A_H$	$C5_H$	CAPCOM Register 9 Interrupt Control Register	0000_H
CC10		$FE94_H$	$4A_H$	CAPCOM Register 10	0000_H
CC10IC	**b**	$FF8C_H$	$C6_H$	CAPCOM Register 10 Interrupt Control Register	0000_H
CC11		$FE96_H$	$4B_H$	CAPCOM Register 11	0000_H
CC11IC	**b**	$FF8E_H$	$C7_H$	CAPCOM Register 11 Interrupt Control Register	0000_H
CC12		$FE98_H$	$4C_H$	CAPCOM Register 12	0000_H
CC12IC	**b**	$FF90_H$	$C8_H$	CAPCOM Register 12 Interrupt Control Register	0000_H
CC13		$FE9A_H$	$4D_H$	CAPCOM Register 13	0000_H
CC13IC	**b**	$FF92_H$	$C9_H$	CAPCOM Register 13 Interrupt Control Register	0000_H
CC14		$FE9C_H$	$4E_H$	CAPCOM Register 14	0000_H
CC14IC	**b**	$FF94_H$	CA_H	CAPCOM Register 14 Interrupt Control Register	0000_H
CC15		$FE9E_H$	$4F_H$	CAPCOM Register 15	0000_H
CC15IC	**b**	$FF96_H$	CB_H	CAPCOM Register 15 Interrupt Control Register	0000_H
CC16		$FE60_H$	30_H	CAPCOM Register 16	0000_H
CC16IC	**b**	$F160_H$	**E** $B0_H$	CAPCOM Register 16 Interrupt Control Register	0000_H
CC17		$FE62_H$	31_H	CAPCOM Register 17	0000_H

Special Function Registers Overview (cont'd)

Name	Physical Address	8-Bit Address	Description	Reset Value
CC17IC b E	$F162_H$	$B1_H$	CAPCOM Register 17 Interrupt Control Register	0000_H
CC18	$FE64_H$	32_H	CAPCOM Register 18	0000_H
CC18IC b E	$F164_H$	$B2_H$	CAPCOM Register 18 Interrupt Control Register	0000_H
CC19	$FE66_H$	33_H	CAPCOM Register 19	0000_H
CC19IC b E	$F166_H$	$B3_H$	CAPCOM Register 19 Interrupt Control Register	0000_H
CC20	$FE68_H$	34_H	CAPCOM Register 20	0000_H
CC20IC b E	$F168_H$	$B4_H$	CAPCOM Register 20 Interrupt Control Register	0000_H
CC21	$FE6A_H$	35_H	CAPCOM Register 21	0000_H
CC21IC b E	$F16A_H$	$B5_H$	CAPCOM Register 21 Interrupt Control Register	0000_H
CC22	$FE6C_H$	36_H	CAPCOM Register 22	0000_H
CC22IC b E	$F16C_H$	$B6_H$	CAPCOM Register 22 Interrupt Control Register	0000_H
CC23	$FE6E_H$	37_H	CAPCOM Register 23	0000_H
CC23IC b E	$F16E_H$	$B7_H$	CAPCOM Register 23 Interrupt Control Register	0000_H
CC24	$FE70_H$	38_H	CAPCOM Register 24	0000_H
CC24IC b E	$F170_H$	$B8_H$	CAPCOM Register 24 Interrupt Control Register	0000_H
CC25	$FE72_H$	39_H	CAPCOM Register 25	0000_H
CC25IC b E	$F172_H$	$B9_H$	CAPCOM Register 25 Interrupt Control Register	0000_H
CC26	$FE74_H$	$3A_H$	CAPCOM Register 26	0000_H
CC26IC b E	$F174_H$	BA_H	CAPCOM Register 26 Interrupt Control Register	0000_H
CC27	$FE76_H$	$3B_H$	CAPCOM Register 27	0000_H
CC27IC b E	$F176_H$	BB_H	CAPCOM Register 27 Interrupt Control Register	0000_H
CC28	$FE78_H$	$3C_H$	CAPCOM Register 28	0000_H
CC28IC b E	$F178_H$	BC_H	CAPCOM Register 28 Interrupt Control Register	0000_H
CC29	$FE7A_H$	$3D_H$	CAPCOM Register 29	0000_H
CC29IC b E	$F184_H$	$C2_H$	CAPCOM Register 29 Interrupt Control Register	0000_H
CC30	$FE7C_H$	$3E_H$	CAPCOM Register 30	0000_H
CC30IC b E	$F18C_H$	$C6_H$	CAPCOM Register 30 Interrupt Control Register	0000_H
CC31	$FE7E_H$	$3F_H$	CAPCOM Register 31	0000_H
CC31IC b E	$F194_H$	CA_H	CAPCOM Register 31 Interrupt Control Register	0000_H

Special Function Registers Overview (cont'd)

Name		Physical Address		8-Bit Address	Description	Reset Value
CCM0	**b**	$FF52_H$		$A9_H$	CAPCOM Mode Control Register 0	0000_H
CCM1	**b**	$FF54_H$		AA_H	CAPCOM Mode Control Register 1	0000_H
CCM2	**b**	$FF56_H$		AB_H	CAPCOM Mode Control Register 2	0000_H
CCM3	**b**	$FF58_H$		AC_H	CAPCOM Mode Control Register 3	0000_H
CCM4	**b**	$FF22_H$		91_H	CAPCOM Mode Control Register 4	0000_H
CCM5	**b**	$FF24_H$		92_H	CAPCOM Mode Control Register 5	0000_H
CCM6	**b**	$FF26_H$		93_H	CAPCOM Mode Control Register 6	0000_H
CCM7	**b**	$FF28_H$		94_H	CAPCOM Mode Control Register 7	0000_H
CP		$FE10_H$		08_H	CPU Context Pointer Register	$FC00_H$
CRIC	**b**	$FF6A_H$		$B5_H$	GPT2 CAPREL Interrupt Control Register	0000_H
CSP		$FE08_H$		04_H	CPU Code Segment Pointer Register (read only)	0000_H
DP0L	**b**	$F100_H$	**E**	80_H	P0L Direction Control Register	00_H
DP0H	**b**	$F102_H$	**E**	81_H	P0H Direction Control Register	00_H
DP1L	**b**	$F104_H$	**E**	82_H	P1L Direction Control Register	00_H
DP1H	**b**	$F106_H$	**E**	83_H	P1H Direction Control Register	00_H
DP2	**b**	$FFC2_H$		$E1_H$	Port 2 Direction Control Register	0000_H
DP3	**b**	$FFC6_H$		$E3_H$	Port 3 Direction Control Register	0000_H
DP4	**b**	$FFCA_H$		$E5_H$	Port 4 Direction Control Register	00_H
DP6	**b**	$FFCE_H$		$E7_H$	Port 6 Direction Control Register	00_H
DP7	**b**	$FFD2_H$		$E9_H$	Port 7 Direction Control Register	00_H
DP8	**b**	$FFD6_H$		EB_H	Port 8 Direction Control Register	00_H
DPP0		$FE00_H$		00_H	CPU Data Page Pointer 0 Register (10 bits)	0000_H
DPP1		$FE02_H$		01_H	CPU Data Page Pointer 1 Register (10 bits)	0001_H
DPP2		$FE04_H$		02_H	CPU Data Page Pointer 2 Register (10 bits)	0002_H
DPP3		$FE06_H$		03_H	CPU Data Page Pointer 3 Register (10 bits)	0003_H
EXICON	**b**	$F1C0_H$	**E**	$E0_H$	External Interrupt Control Register	0000_H
MDC	**b**	$FF0E_H$		87_H	CPU Multiply Divide Control Register	0000_H
MDH		$FE0C_H$		06_H	CPU Multiply Divide Register – High Word	0000_H
MDL		$FE0E_H$		07_H	CPU Multiply Divide Register – Low Word	0000_H

Special Function Registers Overview (cont'd)

Name		Physical Address		8-Bit Address	Description	Reset Value
ODP2	**b**	$F1C2_H$	**E**	$E1_H$	Port 2 Open Drain Control Register	0000_H
ODP3	**b**	$F1C6_H$	**E**	$E3_H$	Port 3 Open Drain Control Register	0000_H
ODP6	**b**	$F1CE_H$	**E**	$E7_H$	Port 6 Open Drain Control Register	00_H
ODP7	**b**	$F1D2_H$	**E**	$E9_H$	Port 7 Open Drain Control Register	00_H
ODP8	**b**	$F1D6_H$	**E**	EB_H	Port 8 Open Drain Control Register	00_H
ONES		$FF1E_H$		$8F_H$	Constant Value 1's Register (read only)	$FFFF_H$
P0L	**b**	$FF00_H$		80_H	Port 0 Low Register (Lower half of PORT0)	00_H
P0H	**b**	$FF02_H$		81_H	Port 0 High Register (Upper half of PORT0)	00_H
P1L	**b**	$FF04_H$		82_H	Port 1 Low Register (Lower half of PORT1)	00_H
P1H	**b**	$FF06_H$		83_H	Port 1 High Register (Upper half of PORT1)	00_H
P2	**b**	$FFC0_H$		$E0_H$	Port 2 Register	0000_H
P3	**b**	$FFC4_H$		$E2_H$	Port 3 Register	0000_H
P4	**b**	$FFC8_H$		$E4_H$	Port 4 Register (8 bits)	00_H
P5	**b**	$FFA2_H$		$D1_H$	Port 5 Register (read only)	$XXXX_H$
P6	**b**	$FFCC_H$		$E6_H$	Port 6 Register (8 bits)	00_H
P7	**b**	$FFD0_H$		$E8_H$	Port 7 Register (8 bits)	00_H
P8	**b**	$FFD4_H$		EA_H	Port 8 Register (8 bits)	00_H
PECC0		$FEC0_H$		60_H	PEC Channel 0 Control Register	0000_H
PECC1		$FEC2_H$		61_H	PEC Channel 1 Control Register	0000_H
PECC2		$FEC4_H$		62_H	PEC Channel 2 Control Register	0000_H
PECC3		$FEC6_H$		63_H	PEC Channel 3 Control Register	0000_H
PECC4		$FEC8_H$		64_H	PEC Channel 4 Control Register	0000_H
PECC5		$FECA_H$		65_H	PEC Channel 5 Control Register	0000_H
PECC6		$FECC_H$		66_H	PEC Channel 6 Control Register	0000_H
PECC7		$FECE_H$		67_H	PEC Channel 7 Control Register	0000_H
PICON		$F1C4_H$	**E**	$E2_H$	Port Input Threshold Control Register	0000_H
PP0		$F038_H$	**E**	$1C_H$	PWM Module Period Register 0	0000_H
PP1		$F03A_H$	**E**	$1D_H$	PWM Module Period Register 1	0000_H
PP2		$F03C_H$	**E**	$1E_H$	PWM Module Period Register 2	0000_H

Special Function Registers Overview (cont'd)

Name	Physical Address	8-Bit Address	Description	Reset Value
PP3	$F03E_H$ **E**	$1F_H$	PWM Module Period Register 3	0000_H
PSW **b**	$FF10_H$	88_H	CPU Program Status Word	0000_H
PT0	$F030_H$ **E**	18_H	PWM Module Up/Down Counter 0	0000_H
PT1	$F032_H$ **E**	19_H	PWM Module Up/Down Counter 1	0000_H
PT2	$F034_H$ **E**	$1A_H$	PWM Module Up/Down Counter 2	0000_H
PT3	$F036_H$ **E**	$1B_H$	PWM Module Up/Down Counter 3	0000_H
PW0	$FE30_H$	18_H	PWM Module Pulse Width Register 0	0000_H
PW1	$FE32_H$	19_H	PWM Module Pulse Width Register 1	0000_H
PW2	$FE34_H$	$1A_H$	PWM Module Pulse Width Register 2	0000_H
PW3	$FE36_H$	$1B_H$	PWM Module Pulse Width Register 3	0000_H
PWMCON0 **b**	$FF30_H$	98_H	PWM Module Control Register 0	0000_H
PWMCON1 **b**	$FF32_H$	99_H	PWM Module Control Register 1	0000_H
PWMIC **b**	$F17E_H$ **E**	BF_H	PWM Module Interrupt Control Register	0000_H
RP0H **b**	$F108_H$ **E**	84_H	System Startup Configuration Register (Rd. only)	XX_H
S0BG	$FEB4_H$	$5A_H$	Serial Channel 0 Baud Rate Generator Reload Register	0000_H
S0CON **b**	$FFB0_H$	$D8_H$	Serial Channel 0 Control Register	0000_H
S0EIC **b**	$FF70_H$	$B8_H$	Serial Channel 0 Error Interrupt Control Register	0000_H
S0RBUF	$FEB2_H$	59_H	Serial Channel 0 Receive Buffer Register (read only)	XX_H
S0RIC **b**	$FF6E_H$	$B7_H$	Serial Channel 0 Receive Interrupt Control Register	0000_H
S0TBIC **b**	$F19C_H$ **E**	CE_H	Serial Channel 0 Transmit Buffer Interrupt Control Register	0000_H
S0TBUF	$FEB0_H$	58_H	Serial Channel 0 Transmit Buffer Register (write only)	00_H
S0TIC **b**	$FF6C_H$	$B6_H$	Serial Channel 0 Transmit Interrupt Control Register	0000_H
SP	$FE12_H$	09_H	CPU System Stack Pointer Register	$FC00_H$
SSCBR	$F0B4_H$ **E**	$5A_H$	SSC Baudrate Register	0000_H
SSCCON **b**	$FFB2_H$	$D9_H$	SSC Control Register	0000_H

Special Function Registers Overview (cont'd)

Name		Physical Address		8-Bit Address	Description	Reset Value
SSCEIC	**b**	$FF76_H$		BB_H	SSC Error Interrupt Control Register	0000_H
SSCRB		$F0B2_H$	**E**	59_H	SSC Receive Buffer (read only)	$XXXX_H$
SSCRIC	**b**	$FF74_H$		BA_H	SSC Receive Interrupt Control Register	0000_H
SSCTB		$F0B0_H$	**E**	58_H	SSC Transmit Buffer (write only)	0000_H
SSCTIC	**b**	$FF72_H$		$B9_H$	SSC Transmit Interrupt Control Register	0000_H
STKOV		$FE14_H$		$0A_H$	CPU Stack Overflow Pointer Register	$FA00_H$
STKUN		$FE16_H$		$0B_H$	CPU Stack Underflow Pointer Register	$FC00_H$
SYSCON	**b**	$FF12_H$		89_H	CPU System Configuration Register	$0xx0_H$ [1)]
T0		$FE50_H$		28_H	CAPCOM Timer 0 Register	0000_H
T01CON	**b**	$FF50_H$		$A8_H$	CAPCOM Timer 0 and Timer 1 Control Register	0000_H
T0IC	**b**	$FF9C_H$		CE_H	CAPCOM Timer 0 Interrupt Control Register	0000_H
T0REL		$FE54_H$		$2A_H$	CAPCOM Timer 0 Reload Register	0000_H
T1		$FE52_H$		29_H	CAPCOM Timer 1 Register	0000_H
T1IC	**b**	$FF9E_H$		CF_H	CAPCOM Timer 1 Interrupt Control Register	0000_H
T1REL		$FE56_H$		$2B_H$	CAPCOM Timer 1 Reload Register	0000_H
T2		$FE40_H$		20_H	GPT1 Timer 2 Register	0000_H
T2CON	**b**	$FF40_H$		$A0_H$	GPT1 Timer 2 Control Register	0000_H
T2IC	**b**	$FF60_H$		$B0_H$	GPT1 Timer 2 Interrupt Control Register	0000_H
T3		$FE42_H$		21_H	GPT1 Timer 3 Register	0000_H
T3CON	**b**	$FF42_H$		$A1_H$	GPT1 Timer 3 Control Register	0000_H
T3IC	**b**	$FF62_H$		$B1_H$	GPT1 Timer 3 Interrupt Control Register	0000_H
T4		$FE44_H$		22_H	GPT1 Timer 4 Register	0000_H
T4CON	**b**	$FF44_H$		$A2_H$	GPT1 Timer 4 Control Register	0000_H
T4IC	**b**	$FF64_H$		$B2_H$	GPT1 Timer 4 Interrupt Control Register	0000_H
T5		$FE46_H$		23_H	GPT2 Timer 5 Register	0000_H
T5CON	**b**	$FF46_H$		$A3_H$	GPT2 Timer 5 Control Register	0000_H
T5IC	**b**	$FF66_H$		$B3_H$	GPT2 Timer 5 Interrupt Control Register	0000_H
T6		$FE48_H$		24_H	GPT2 Timer 6 Register	0000_H
T6CON	**b**	$FF48_H$		$A4_H$	GPT2 Timer 6 Control Register	0000_H

Special Function Registers Overview (cont'd)

Name		Physical Address		8-Bit Address	Description	Reset Value
T6IC	**b**	$FF68_H$		$B4_H$	GPT2 Timer 6 Interrupt Control Register	0000_H
T7		$F050_H$	**E**	28_H	CAPCOM Timer 7 Register	0000_H
T78CON	**b**	$FF20_H$		90_H	CAPCOM Timer 7 and 8 Control Register	0000_H
T7IC	**b**	$F17A_H$	**E**	BE_H	CAPCOM Timer 7 Interrupt Control Register	0000_H
T7REL		$F054_H$	**E**	$2A_H$	CAPCOM Timer 7 Reload Register	0000_H
T8		$F052_H$	**E**	29_H	CAPCOM Timer 8 Register	0000_H
T8IC	**b**	$F17C_H$	**E**	BF_H	CAPCOM Timer 8 Interrupt Control Register	0000_H
T8REL		$F056_H$	**E**	$2B_H$	CAPCOM Timer 8 Reload Register	0000_H
TFR	**b**	$FFAC_H$		$D6_H$	Trap Flag Register	0000_H
WDT		$FEAE_H$		57_H	Watchdog Timer Register (read only)	0000_H
WDTCON		$FFAE_H$		$D7_H$	Watchdog Timer Control Register	$000X_H$ [2]
XP0IC	**b**	$F186_H$	**E**	$C3_H$	CAN Module Interrupt Control Register	0000_H
XP1IC	**b**	$F18E_H$	**E**	$C7_H$	X-Peripheral 1 Interrupt Control Register	0000_H
XP2IC	**b**	$F196_H$	**E**	CB_H	X-Peripheral 2 Interrupt Control Register	0000_H
XP3IC	**b**	$F19E_H$	**E**	CF_H	PLL Interrupt Control Register	0000_H
ZEROS	**b**	$FF1C_H$		$8E_H$	Constant Value 0's Register (read only)	0000_H

[1] The system configuration is selected during reset.

[2] Bit WDTR indicates a watchdog timer triggered reset.

Note: The Interrupt Control Registers XPnIC are prepared to control interrupt requests from integrated X-Bus peripherals. Nodes, where no X-Peripherals are connected, may be used to generate software controlled interrupt requests by setting the respective XPnIR bit.

Absolute Maximum Ratings

Ambient temperature under bias (T_A):
SAB-C167CR-LM ..... 0 to + 70 °C
SAF-C167CR-LM ..... – 40 to + 85 °C
SAK-C167CR-LM ..... – 40 to + 125 °C
Storage temperature (T_{ST}) ..... – 65 to + 150 °C
Voltage on V_{CC} pins with respect to ground (V_{SS}) ..... – 0.5 to + 6.5 V
Voltage on any pin with respect to ground (V_{SS}) ..... – 0.5 to V_{CC} + 0.5 V
Input current on any pin during overload condition ..... – 10 to + 10 mA
Absolute sum of all input currents during overload condition ..... |100 mA|
Power dissipation ..... 1.5 W

Note: Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. During overload conditions ($V_{IN} > V_{CC}$ or $V_{IN} < V_{SS}$) the voltage on pins with respect to ground (V_{SS}) must not exceed the values defined by the Absolute Maximum Ratings.

Parameter Interpretation

The parameters listed in the following partly represent the characteristics of the C167CR and partly its demands on the system. To aid in interpreting the parameters right, when evaluating them for a design, they are marked in column “Symbol”:

CC (**C**ontroller **C**haracteristics):
The logic of the C167CR will provide signals with the respective timing characteristics.

SR (**S**ystem **R**equirement):
The external system must provide signals with the respective timing characteristics to the C167CR.

DC Characteristics

V_{CC} = 5 V ± 10 %; V_{SS} = 0 V; f_{CPU} = 20 MHz; Reset active
T_A = 0 to +70 ˚C for SAB-C167CR-LM
T_A = – 40 to + 85 ˚C for SAF-C167CR-LM
T_A = – 40 to + 125 ˚C for SAK-C167CR-LM

Parameter	Symbol		Limit Values		Unit	Test Condition
			min.	max.		
Input low voltage (TTL)	V_{IL}	SR	– 0.5	0.2 V_{CC} – 0.1	V	–
Input low voltage (Special Threshold)	V_{ILS}	SR	– 0.5	2.0	V	–
Input high voltage, all except $\overline{\text{RSTIN}}$ and XTAL1 (TTL)	V_{IH}	SR	0.2 V_{CC} + 0.9	V_{CC} + 0.5	V	–
Input high voltage $\overline{\text{RSTIN}}$	V_{IH1}	SR	0.6 V_{CC}	V_{CC} + 0.5	V	–
Input high voltage XTAL1	V_{IH2}	SR	0.7 V_{CC}	V_{CC} + 0.5	V	–
Input high voltage (Special Threshold)	V_{IHS}	SR	0.8 V_{CC} – 0.2	V_{CC} + 0.5	V	–
Input Hysteresis (Special Threshold)	HYS		400	–	mV	–
Output low voltage (PORT0, PORT1, Port 4, ALE, $\overline{\text{RD}}$, $\overline{\text{WR}}$, $\overline{\text{BHE}}$, CLKOUT, $\overline{\text{RSTOUT}}$)	V_{OL}	CC	–	0.45	V	I_{OL} = 2.4 mA
Output low voltage (all other outputs)	V_{OL1}	CC	–	0.45	V	I_{OL1} = 1.6 mA
Output high voltage (PORT0, PORT1, Port 4, ALE, $\overline{\text{RD}}$, $\overline{\text{WR}}$, $\overline{\text{BHE}}$, CLKOUT, $\overline{\text{RSTOUT}}$)	V_{OH}	CC	0.9 V_{CC} 2.4	–	V	I_{OH} = – 500 µA I_{OH} = – 2.4 mA
Output high voltage [1] (all other outputs)	V_{OH1}	CC	0.9 V_{CC} 2.4	–	V V	I_{OH} = – 250 µA I_{OH} = – 1.6 mA
Input leakage current (Port 5)	I_{OZ1}	CC	–	±200	nA	0.45V < V_{IN} < V_{CC}
Input leakage current (all other)	I_{OZ2}	CC	–	±500	nA	0.45V < V_{IN} < V_{CC}
Overload current	I_{OV}	SR	–	±5	mA	[5] [8]
$\overline{\text{RSTIN}}$ pullup resistor	R_{RST}	CC	50	250	kΩ	–
Read/Write inactive current [4]	I_{RWH}	[2]	–	– 40	µA	V_{OUT} = 2.4 V
Read/Write active current [4]	I_{RWL}	[3]	– 500	–	µA	V_{OUT} = V_{OLmax}
ALE inactive current [4]	I_{ALEL}	[2]	–	40	µA	V_{OUT} = V_{OLmax}
ALE active current [4]	I_{ALEH}	[3]	500	–	µA	V_{OUT} = 2.4 V
Port 6 inactive current [4]	I_{P6H}	[2]	–	– 40	µA	V_{OUT} = 2.4 V

Parameter	Symbol	Limit Values		Unit	Test Condition
		min.	max.		
Port 6 active current [4]	I_{P6L} [3]	– 500	–	µA	$V_{OUT} = V_{OL1max}$
PORT0 configuration current [4]	I_{P0H} [2]	–	– 10	µA	$V_{IN} = V_{IHmin}$
	I_{P0L} [3]	– 100	–	µA	$V_{IN} = V_{ILmax}$
XTAL1 input current	I_{IL} CC	–	± 20	µA	0 V < V_{IN} < V_{CC}
Pin capacitance [5] (digital inputs/outputs)	C_{IO} CC	–	10	pF	f = 1 MHz T_A = 25 °C
Power supply current	I_{CC}	–	20 + 5 × f_{CPU}	mA	$\overline{RSTIN} = V_{IL2}$ f_{CPU} in [MHz] [6]
Idle mode supply current	I_{ID}	–	20 + 2 × f_{CPU}	mA	$\overline{RSTIN} = V_{IH1}$ f_{CPU} in [MHz] [6]
Power-down mode supply current	I_{PD}	–	100	µA	V_{CC} = 5.5 V [7]

Notes

1) This specification is not valid for outputs which are switched to open drain mode. In this case the respective output will float and the voltage results from the external circuitry.

2) The maximum current may be drawn while the respective signal line remains inactive.

3) The minimum current must be drawn in order to drive the respective signal line active.

4) This specification is only valid during Reset, or during Hold- or Adapt-mode. Port 6 pins are only affected, if they are used for $\overline{CS}$ output and the open drain function is not enabled.

5) Not 100 % tested, guaranteed by design characterization.

6) The supply current is a function of the operating frequency. This dependency is illustrated in the figure below. These parameters are tested at V_{CCmax} and 20 MHz CPU clock with all outputs disconnected and all inputs at V_{IL} or V_{IH}.

7) This parameter is tested including leakage currents. All inputs (including pins configured as inputs) at 0 V to 0.1 V or at V_{CC} – 0.1 V to V_{CC}, V_{REF} = 0 V, all outputs (including pins configured as outputs) disconnected.

8) Overload conditions occur if the standard operatings conditions are exceeded, i.e. the voltage on any pin exceeds the specified range (i.e. $V_{OV} > V_{CC}$ + 0.5 V or $V_{OV} < V_{SS}$ – 0.5V). The absolute sum of input overload currents on all port pins may not exceed **50 mA**.

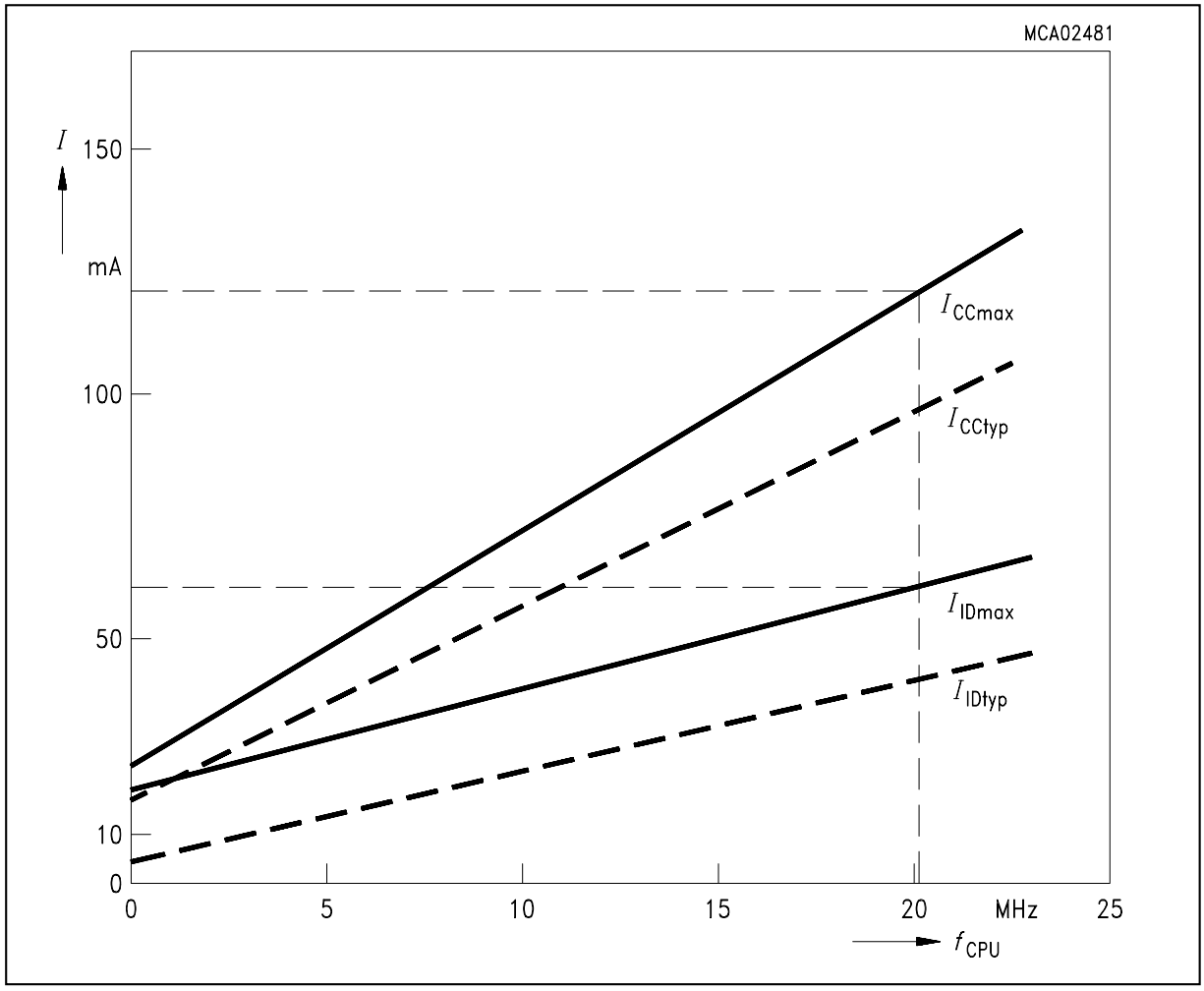


Figure 8
Supply/Idle Current as a Function of Operating Frequency

A/D Converter Characteristics

V_{CC} = 5 V ± 10 %; V_{SS} = 0 V
T_A = 0 to + 70 °C for SAB-C167CR-LM
T_A = – 40 to + 85 °C for SAF-C167CR-LM
T_A = – 40 to + 125 °C for SAK-C167CR-LM
4.0 V ≤ V_{AREF} ≤ V_{CC} + 0.1 V; V_{SS} – 0.1 V ≤ V_{AGND} ≤ V_{SS} + 0.2 V

Parameter	Symbol		Limit Values		Unit	Test Condition
			min.	max.		
Analog input voltage range	V_{AIN}	SR	V_{AGND}	V_{AREF}	V	1)
Sample time	t_S	CC	–	2 t_{SC}		2) 4)
Conversion time	t_C	CC	–	14 t_{CC} + t_S + 4TCL		3) 4)
Total unadjusted error	TUE	CC	–	± 2	LSB	5)
Internal resistance of reference voltage source	R_{AREF}	SR	–	t_{CC} / 165 – 0.25	kΩ	t_{CC} in [ns] 6) 7)
Internal resistance of analog source	R_{ASRC}	SR	–	t_S / 330 – 0.25	kΩ	t_S in [ns] 2) 7)
ADC input capacitance	C_{AIN}	CC	–	33	pF	7)

Sample time and conversion time of the C167CR's ADC are programmable. The table below should be used to calculate the above timings.

ADCON.15|14 (ADCTC)	Conversion Clock t_{CC}	ADCON.13|12 (ADSTC)	Sample Clock t_{SC}
00	TCL × 24	00	t_{CC}
01	Reserved, do not use	01	t_{CC} × 2
10	TCL × 96	10	t_{CC} × 4
11	TCL × 48	11	t_{CC} × 8

Notes

1) V_{AIN} may exceed V_{AGND} or V_{AREF} up to the absolute maximum ratings. However, the conversion result in these cases will be $X000_H$ or $X3FF_H$, respectively.

2) During the sample time the input capacitance C_I can be charged/discharged by the external source. The internal resistance of the analog source must allow the capacitance to reach its final voltage level within t_S. After the end of the sample time t_S, changes of the analog input voltage have no effect on the conversion result. Values for the sample clock t_{SC} depend on programming and can be taken from the table above.

3) This parameter includes the sample time t_S, the time for determining the digital result and the time to load the result register with the conversion result.
Values for the conversion clock t_{CC} depend on programming and can be taken from the table above.

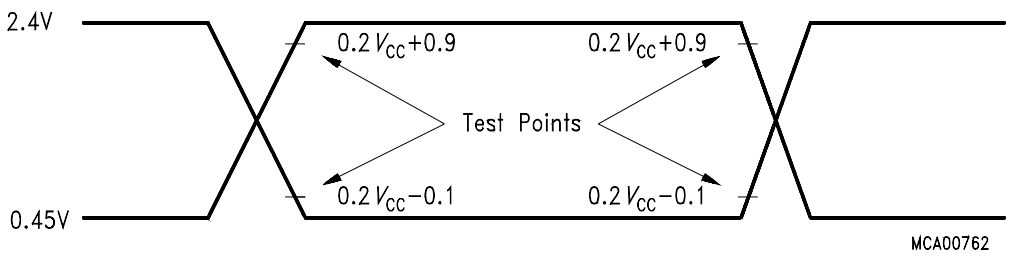
4) This parameter depends on the ADC control logic. It is not a real maximum value, but rather a fixum.

5) TUE is tested at V_{AREF} = 5.0 V, V_{AGND} = 0 V, V_{CC} = 4.9 V. It is guaranteed by design characterization for all other voltages within the defined voltage range.
The specified TUE is guaranteed only if an overload condition (see I_{OV} specification) occurs on maximum 2 not selected analog input pins and the absolute sum of input overload currents on all analog input pins does not exceed 10 mA.
During the reset calibration sequence the maximum TUE may be $\pm$ 4 LSB.

6) During the conversion the ADC's capacitance must be repeatedly charged or discharged. The internal resistance of the reference voltage source must allow the capacitance to reach its respective voltage level within t_{CC}. The maximum internal resistance results from the programmed conversion timing.

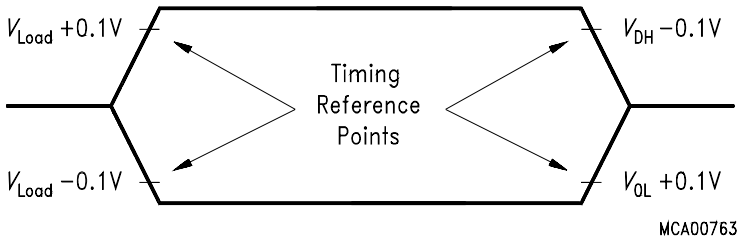
7) Not 100 % tested, guaranteed by design characterization.

Testing Waveforms



AC inputs during testing are driven at 2.4 V for a logic ‘1’ and 0.4 V for a logic ‘0’. Timing measurements are made at V_{IH} min for a logic ‘1’ and V_{IL} max for a logic ‘0’.

Figure 9
Input Output Waveforms



For timing purposes a port pin is no longer floating when a 100 mV change from load voltage occurs, but begins to float when a 100 mV change from the loaded V_{OH}/V_{OL} level occurs (I_{OH}/I_{OL} = 20 mA).

Figure 10
Float Waveforms

AC Characteristics
Definition of Internal Timing

The internal operation of the C167CR is controlled by the internal CPU clock f_{CPU}. Both edges of the CPU clock can trigger internal (e.g. pipeline) or external (e.g. bus cycles) operations.

The specification of the external timing (AC Characteristics) therefore depends on the time between two consecutive edges of the CPU clock, called “TCL” (see figure below).

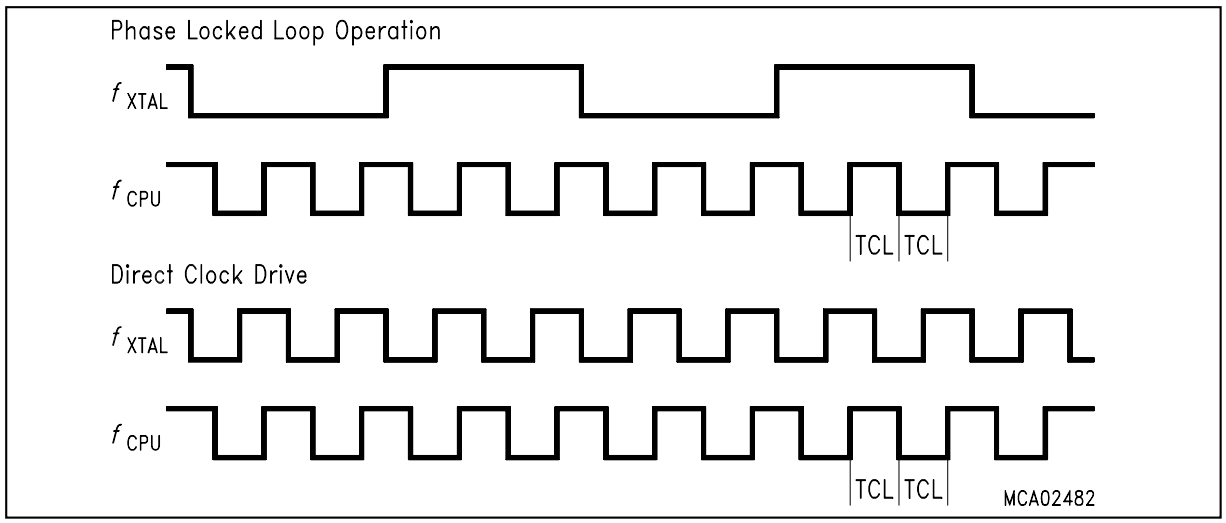


Figure 11
Generation Mechanisms for the CPU Clock

The CPU clock signal can be generated via different mechanisms. The duration of TCLs and their variation (and also the derived external timing) depends on the used mechanism to generate f_{CPU}. This influence must be regarded when calculating the timings for the C167CR.

Direct Drive

When pin P0.15 (P0H.7) is low (‘0’) during reset the on-chip phase locked loop is disabled and the CPU clock is directly driven from the oscillator with the input clock signal.
The frequency of f_{CPU} directly follows the frequency of f_{XTAL} so the high and low time of f_{CPU} (i.e. the duration of an individual TCL) is defined by the duty cycle of the input clock f_{XTAL}.

The timings listed below that refer to TCLs therefore must be calculated using the minimum TCL that is possible under the respective circumstances. This minimum value can be calculated via the following formula:

$$TCL_{min} = 1/f_{XTAL} \times DC_{min} \qquad \text{(DC = duty cycle)}$$

For two consecutive TCLs the deviation caused by the duty cycle of f_{XTAL} is compensated so the duration of 2TCL is always $1/f_{XTAL}$. The minimum value TCL_{min} therefore has to be used only once for timings that require an odd number of TCLs (1,3,...). Timings that require an even number of TCLs (2,4,...) may use the formula $2TCL = 1/f_{XTAL}$.

Note: The address float timings in Multiplexed bus mode (t_{11} and t_{45}) use the maximum duration of TCL ($TCL_{max} = 1/f_{XTAL} \times DC_{max}$) instead of TCL_{min}.

Phase Locked Loop

When pin P0.15 (P0H.7) is high (‘1’) during reset the on-chip phase locked loop is enabled and provides the CPU clock. The PLL multiplies the input frequency by 4 (i.e. $f_{CPU} = f_{XTAL} \times 4$). With every fourth transition of f_{XTAL} the PLL circuit synchronizes the CPU clock to the input clock. This synchronization is done smoothly, i.e. the CPU clock frequency does not change abruptly.

Due to this adaptation to the input clock the frequency of f_{CPU} is constantly adjusted so it is locked to f_{XTAL}. The slight variation causes a jitter of f_{CPU} which also effects the duration of individual TCLs.

The timings listed in the AC Characteristics that refer to TCLs therefore must be calculated using the minimum TCL that is possible under the respective circumstances.

The actual minimum value for TCL depends on the jitter of the PLL. As the PLL is constantly adjusting its output frequency so it corresponds to the applied input frequency (crystal or oscillator) the relative deviation for periods of more than one TCL is lower than for one single TCL (see formula and figure below).
For a period of $\boldsymbol{N} \times$ TCL the minimum value is computed using the corresponding deviation $D_{\boldsymbol{N}}$:

$$TCL_{min} = TCL_{NOM} \times (1 - D_{\boldsymbol{N}} / 100)$$

$D_{\boldsymbol{N}} = \pm (4 - \boldsymbol{N}/15)$ [%],
where $\boldsymbol{N}$ = number of consecutive TCLs
and $1 \le \boldsymbol{N} \le 40$.

So for a period of 3 TCLs (i.e. $\boldsymbol{N} = 3$): $D_{\boldsymbol{3}} = 4 - \boldsymbol{3}/15 = 3.8$ %,
and $TCL_{min} = TCL_{NOM} \times (1 - 3.8 / 100) = TCL_{NOM} \times 0.962$ (24.1 nsec @ f_{CPU} = 20 MHz).

This is especially important for bus cycles using waitstates and e.g. for the operation of timers, serial interfaces, etc. For all slower operations and longer periods (e.g. pulse train generation or measurement, lower baudrates, etc.) the deviation caused by the PLL jitter is neglectible.

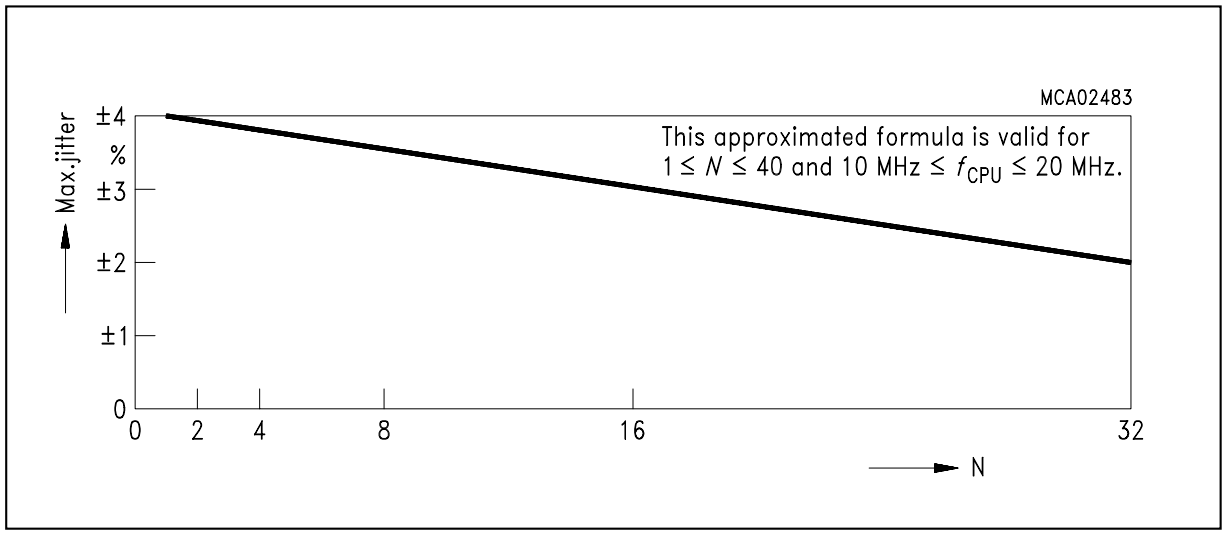


Figure 12
Approximated Maximum PLL Jitter

AC Characteristics
External Clock Drive XTAL1

V_{CC} = 5 V ± 10 %; V_{SS} = 0 V
T_A = 0 to + 70 ˚C for SAB-C167CR-LM
T_A = – 40 to + 85 ˚C for SAF-C167CR-LM
T_A = – 40 to + 125 ˚C for SAK-C167CR-LM

Parameter	Symbol		Direct Drive 1:1		PLL 1:4		Unit
			min.	max.	min.	max.	
Oscillator period	t_{OSC}	SR	50	1000	200	333	ns
High time	t_1	SR	23 [1) 2)]	–	10	–	ns
Low time	t_2	SR	23 [1) 2)]	–	10	–	ns
Rise time	t_3	SR	–	10 [2)]	–	10 [2)]	ns
Fall time	t_4	SR	–	10 [2)]	–	10 [2)]	ns

[1)] For temperatures above T_A = + 85 ˚C the minimum value for t_1 and t_2 is 25 ns.
[2)] The clock input signal must reach the defined levels V_{IL} and V_{IH2}.

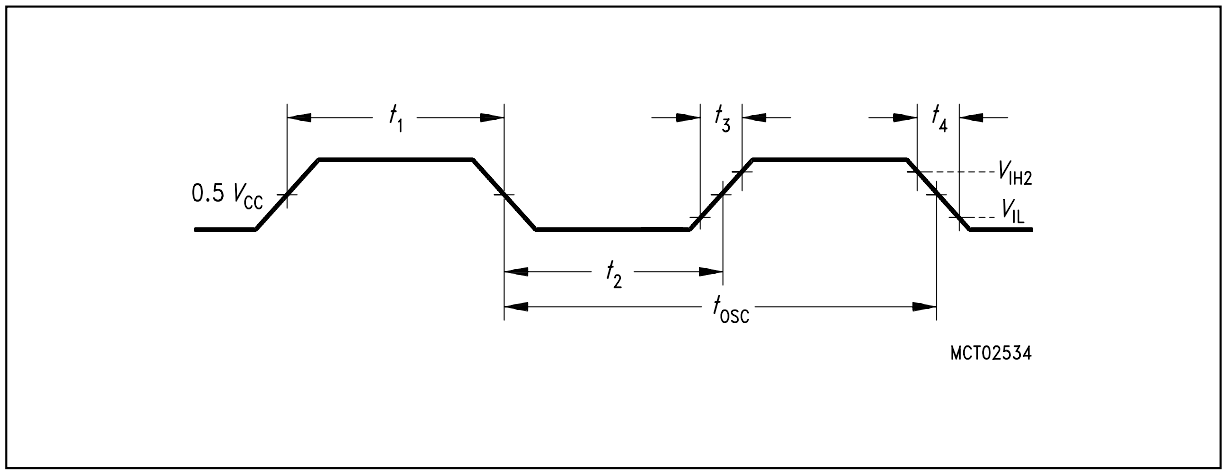


Figure 13
External Clock Drive XTAL1

Memory Cycle Variables

The timing tables below use three variables which are derived from the BUSCONx registers and represent the special characteristics of the programmed memory cycle. The following table describes, how these variables are to be computed.

Description	Symbol	Values
ALE Extension	t_A	TCL × <ALECTL>
Memory Cycle Time Waitstates	t_C	2TCL × (15 – <MCTC>)
Memory Tristate Time	t_F	2TCL × (1 – <MTTC>)

AC Characteristics
Multiplexed Bus

V_{CC} = 5 V ± 10 %; V_{SS} = 0 V
T_A = 0 to + 70 °C for SAB-C167CR-LM
T_A = – 40 to + 85 °C for SAF-C167CR-LM
T_A = – 40 to + 125 °C for SAK-C167CR-LM
C_L (for PORT0, PORT1, Port 4, ALE, $\overline{RD}$, $\overline{WR}$, $\overline{BHE}$, CLKOUT) = 100 pF
C_L (for Port 6, $\overline{CS}$) = 100 pF
ALE cycle time = 6 TCL + 2t_A + t_C + t_F (150 ns at 20-MHz CPU clock without waitstates)

Parameter	Symbol		Max. CPU Clock = 20 MHz		Variable CPU Clock 1/2TCL = 1 to 20 MHz		Unit
			min.	max.	min.	max.	
ALE high time	t_5	CC	15 + t_A	–	TCL – 10 + t_A	–	ns
Address setup to ALE	t_6	CC	10 + t_A	–	TCL – 15 + t_A	–	ns
Address hold after ALE	t_7	CC	15 + t_A	–	TCL – 10 + t_A	–	ns
ALE falling edge to $\overline{RD}$, $\overline{WR}$ (with RW-delay)	t_8	CC	15 + t_A	–	TCL – 10 + t_A	–	ns
ALE falling edge to $\overline{RD}$, $\overline{WR}$ (no RW-delay)	t_9	CC	– 10 + t_A	–	– 10 + t_A	–	ns
Address float after $\overline{RD}$, $\overline{WR}$ (with RW-delay)	t_{10}	CC	–	5	–	5	ns
Address float after $\overline{RD}$, $\overline{WR}$ (no RW-delay)	t_{11}	CC	–	30	–	TCL + 5	ns
$\overline{RD}$, $\overline{WR}$ low time (with RW-delay)	t_{12}	CC	40 + t_C	–	2TCL – 10 + t_C	–	ns
$\overline{RD}$, $\overline{WR}$ low time (no RW-delay)	t_{13}	CC	65 + t_C	–	3TCL – 10 + t_C	–	ns

Parameter	Symbol		Max. CPU Clock = 20 MHz		Variable CPU Clock 1/2TCL = 1 to 20 MHz		Unit
			min.	max.	min.	max.	
$\overline{RD}$ to valid data in (with RW-delay)	t_{14}	SR	–	30 + t_C	–	2TCL – 20 + t_C	ns
$\overline{RD}$ to valid data in (no RW-delay)	t_{15}	SR	–	55 + t_C	–	3TCL – 20 + t_C	ns
ALE low to valid data in	t_{16}	SR	–	55 + t_A + t_C	–	3TCL – 20 + t_A + t_C	ns
Address to valid data in	t_{17}	SR	–	70 + 2t_A + t_C	–	4TCL – 30 + 2t_A + t_C	ns
Data hold after $\overline{RD}$ rising edge	t_{18}	SR	0	–	0	–	ns
Data float after $\overline{RD}$	t_{19}	SR	–	35 + t_F	–	2TCL – 15 + t_F	ns
Data valid to $\overline{WR}$	t_{22}	SR	25 + t_C	–	2TCL – 25 + t_C	–	ns
Data hold after $\overline{WR}$	t_{23}	CC	35 + t_F	–	2TCL – 15 + t_F	–	ns
ALE rising edge after $\overline{RD}$, $\overline{WR}$	t_{25}	CC	35 + t_F	–	2TCL – 15 + t_F	–	ns
Address hold after $\overline{RD}$, $\overline{WR}$	t_{27}	CC	35 + t_F	–	2TCL – 15 + t_F	–	ns
ALE falling edge to $\overline{CS}$	t_{38}	CC	– 5 – t_A	10 – t_A	– 5 – t_A	10 – t_A	ns
$\overline{CS}$ low to Valid Data In	t_{39}	SR	–	55 + t_C + 2t_A	–	3TCL – 20 + t_C + 2t_A	ns
$\overline{CS}$ hold after $\overline{RD}$, $\overline{WR}$	t_{40}	CC	60 + t_F	–	3TCL – 15 + t_F	–	ns
ALE fall. edge to $\overline{RdCS}$, $\overline{WrCS}$ (with RW delay)	t_{42}	CC	20 + t_A	–	TCL – 5 + t_A	–	ns
ALE fall. edge to $\overline{RdCS}$, $\overline{WrCS}$ (no RW delay)	t_{43}	CC	– 5 + t_A	–	– 5 + t_A	–	ns
Address float after $\overline{RdCS}$, $\overline{WrCS}$ (with RW delay)	t_{44}	CC	–	0	–	0	ns
Address float after $\overline{RdCS}$, $\overline{WrCS}$ (no RW delay)	t_{45}	CC	–	25	–	TCL	ns
$\overline{RdCS}$ to Valid Data In (with RW delay)	t_{46}	SR	–	25 + t_C	–	2TCL – 25 + t_C	ns

Parameter	Symbol		Max. CPU Clock = 20 MHz		Variable CPU Clock 1/2TCL = 1 to 20 MHz		Unit
			min.	max.	min.	max.	
$\overline{\text{RdCS}}$ to Valid Data In (no RW delay)	t_{47}	SR	–	50 + t_C	–	3TCL – 25 + t_C	ns
$\overline{\text{RdCS}}$, $\overline{\text{WrCS}}$ Low Time (with RW delay)	t_{48}	CC	40 + t_C	–	2TCL – 10 + t_C	–	ns
$\overline{\text{RdCS}}$, $\overline{\text{WrCS}}$ Low Time (no RW delay)	t_{49}	CC	65 + t_C	–	3TCL – 10 + t_C	–	ns
Data valid to $\overline{\text{WrCS}}$	t_{50}	CC	35 + t_C	–	2TCL – 15 + t_C	–	ns
Data hold after $\overline{\text{RdCS}}$	t_{51}	SR	0	–	0	–	ns
Data float after $\overline{\text{RdCS}}$	t_{52}	SR	–	30 + t_F	–	2TCL – 20 + t_F	ns
Address hold after $\overline{\text{RdCS}}$, $\overline{\text{WrCS}}$	t_{54}	CC	30 + t_F	–	2TCL – 20 + t_F	–	ns
Data hold after $\overline{\text{WrCS}}$	t_{56}	CC	30 + t_F	–	2TCL – 20 + t_F	–	ns

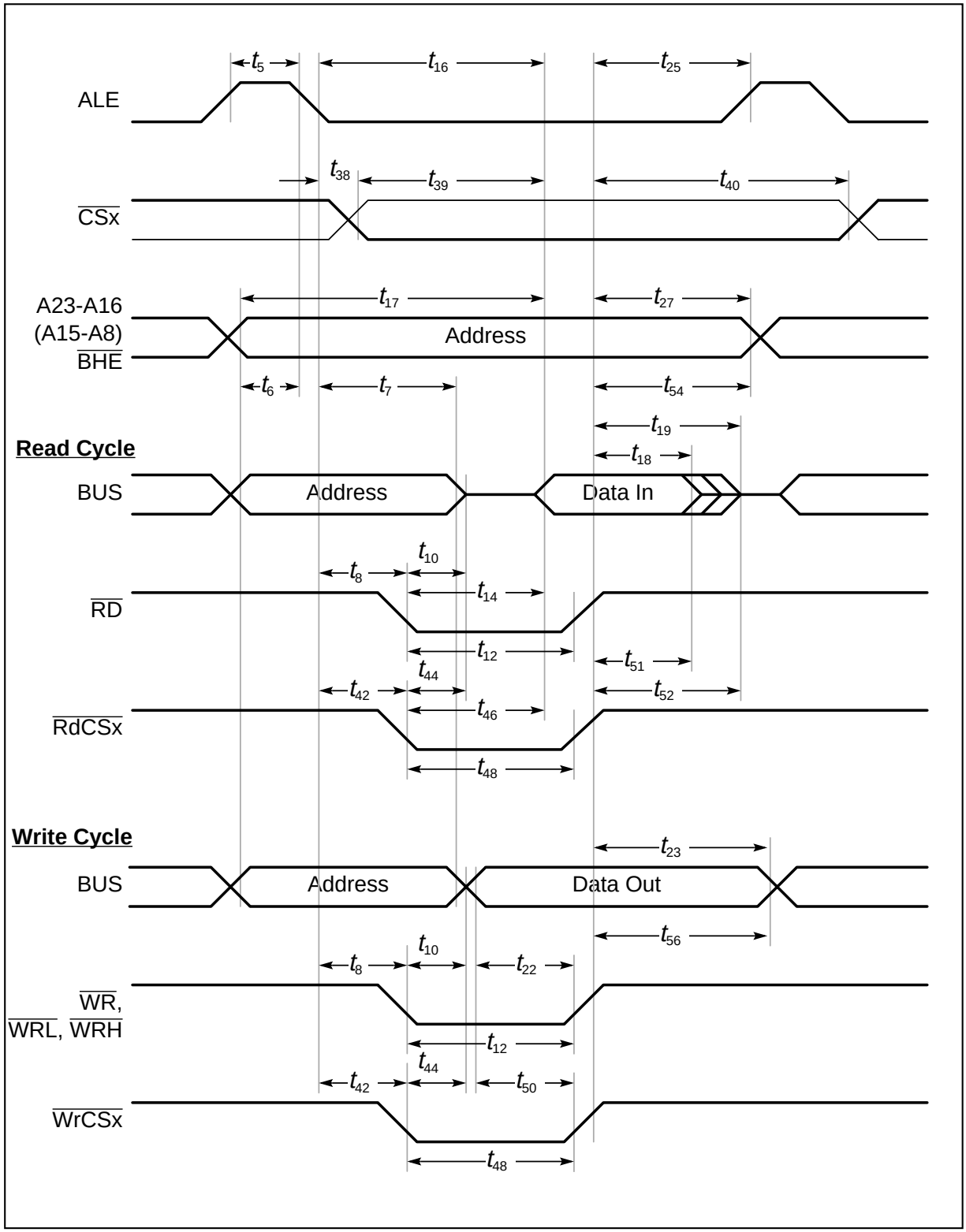


Figure 14-1
External Memory Cycle: Multiplexed Bus, With Read/Write Delay, Normal ALE

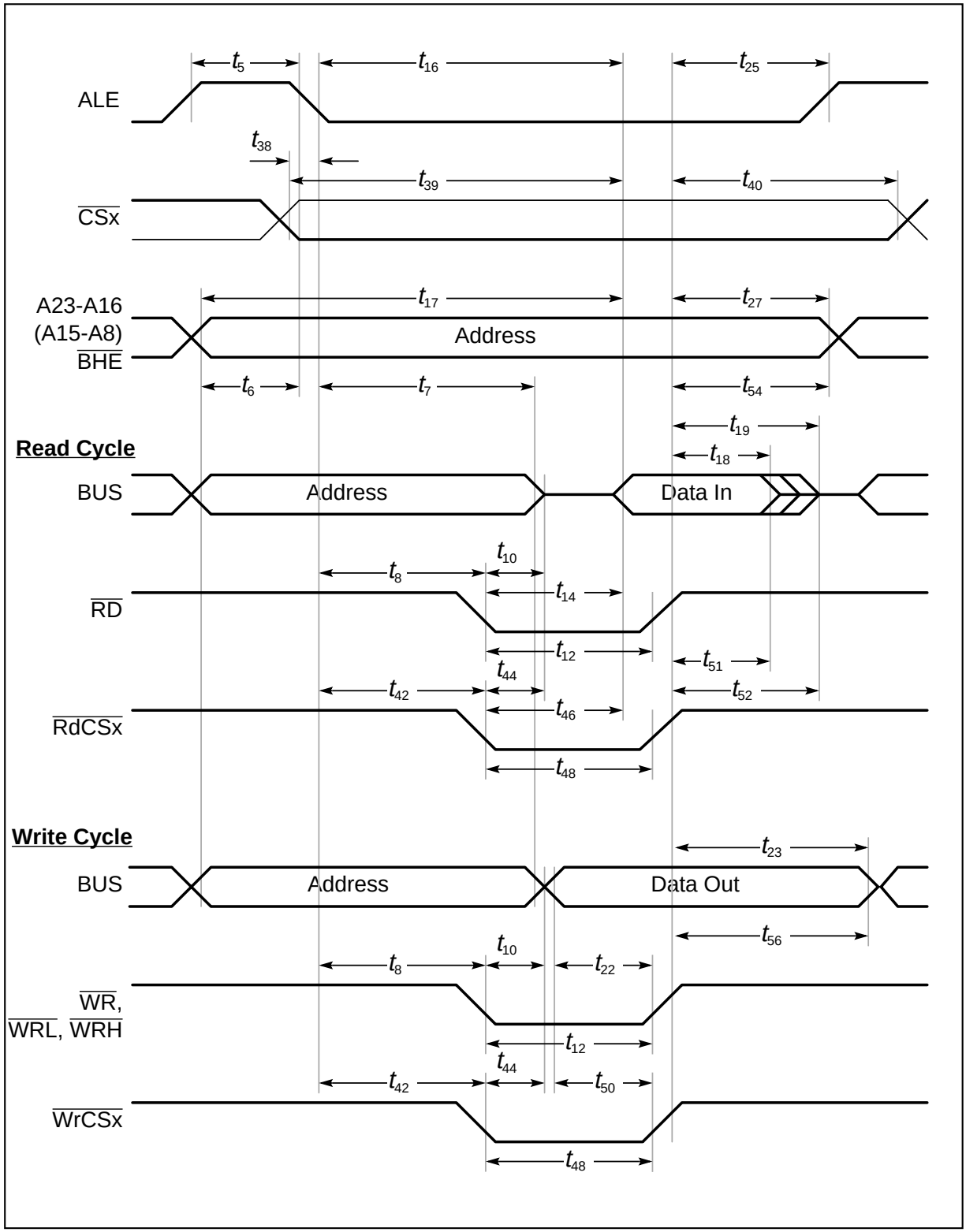


Figure 14-2
External Memory Cycle: Multiplexed Bus, With Read/Write Delay, Extended ALE

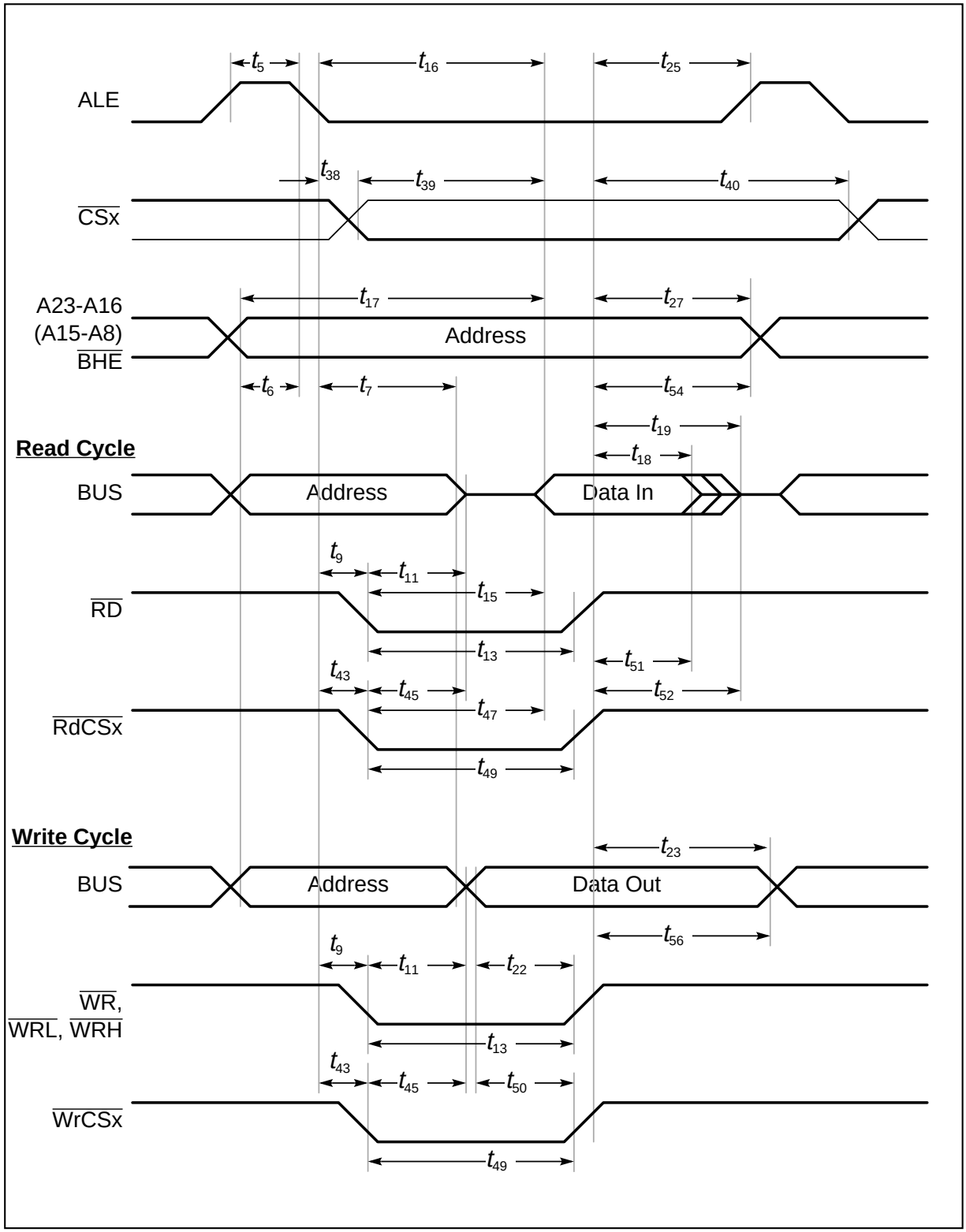


Figure 14-3
External Memory Cycle: Multiplexed Bus, No Read/Write Delay, Normal ALE

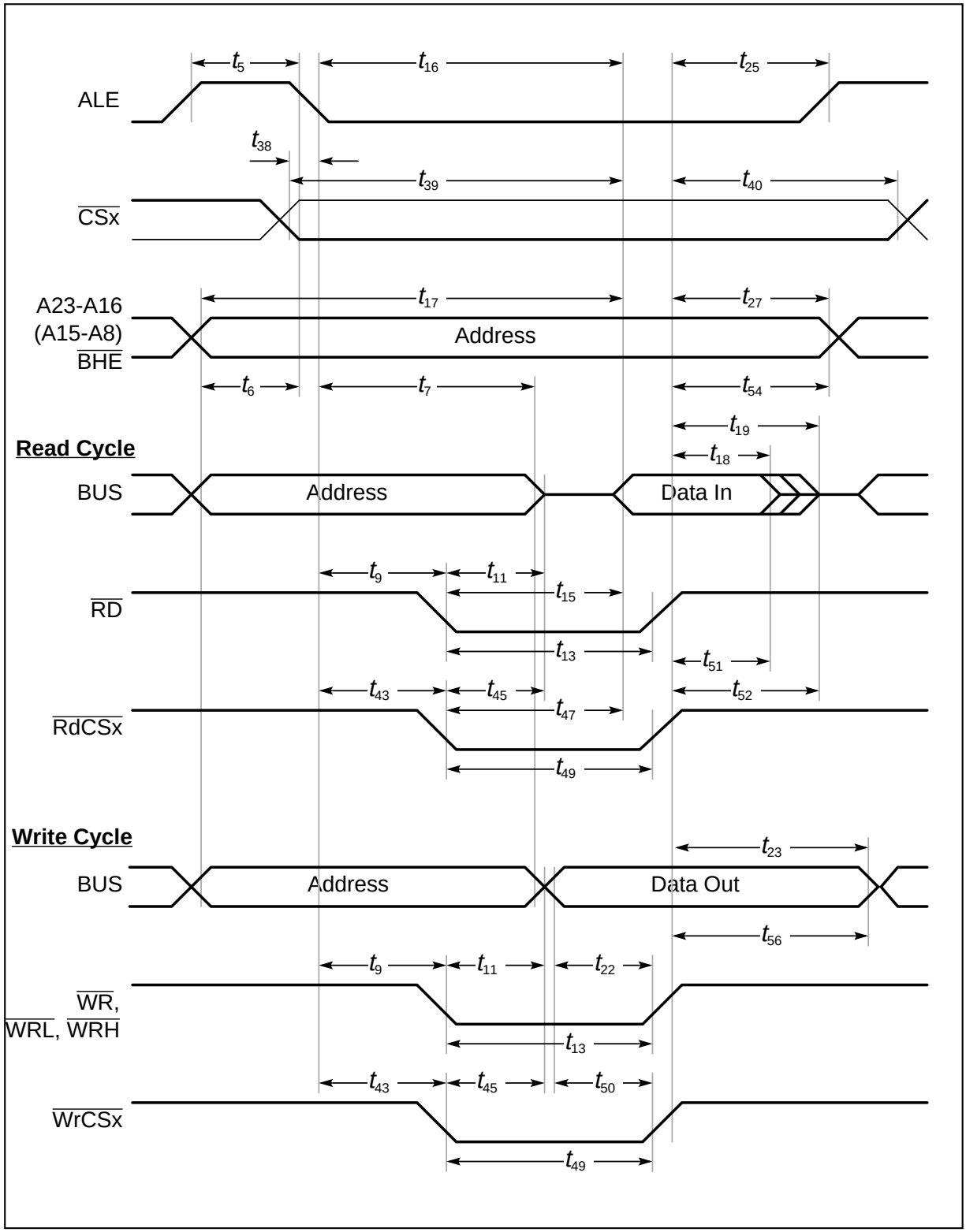


Figure 14-4
External Memory Cycle: Multiplexed Bus, No Read/Write Delay, Extended ALE

AC Characteristics
Demultiplexed Bus

V_{CC} = 5 V ± 10 %; V_{SS} = 0 V
T_A = 0 to + 70 °C for SAB-C167CR-LM
T_A = – 40 to + 85 °C for SAF-C167CR-LM
T_A = – 40 to + 125 °C for SAK-C167CR-LM
C_L (for PORT0, PORT1, Port 4, ALE, $\overline{RD}$, $\overline{WR}$, $\overline{BHE}$, CLKOUT) = 100 pF
C_L (for Port 6, $\overline{CS}$) = 100 pF
ALE cycle time = 4 TCL + 2t_A + t_C + t_F (100 ns at 20-MHz CPU clock without waitstates)

Parameter	Symbol		Max. CPU Clock = 20 MHz		Variable CPU Clock 1/2TCL = 1 to 20 MHz		Unit
			min.	max.	min.	max.	
ALE high time	t_5	CC	15 + t_A	–	TCL – 10 + t_A	–	ns
Address setup to ALE	t_6	CC	10 + t_A	–	TCL – 15 + t_A	–	ns
ALE falling edge to $\overline{RD}$, $\overline{WR}$ (with RW-delay)	t_8	CC	15 + t_A	–	TCL – 10 + t_A	–	ns
ALE falling edge to $\overline{RD}$, $\overline{WR}$ (no RW-delay)	t_9	CC	– 10 + t_A	–	– 10 + t_A	–	ns
$\overline{RD}$, $\overline{WR}$ low time (with RW-delay)	t_{12}	CC	40 + t_C	–	2TCL – 10 + t_C	–	ns
$\overline{RD}$, $\overline{WR}$ low time (no RW-delay)	t_{13}	CC	65 + t_C	–	3TCL – 10 + t_C	–	ns
$\overline{RD}$ to valid data in (with RW-delay)	t_{14}	SR	–	30 + t_C	–	2TCL – 20 + t_C	ns
$\overline{RD}$ to valid data in (no RW-delay)	t_{15}	SR	–	55 + t_C	–	3TCL – 20 + t_C	ns
ALE low to valid data in	t_{16}	SR	–	55 + t_A + t_C	–	3TCL – 20 + t_A + t_C	ns
Address to valid data in	t_{17}	SR	–	70 + 2t_A + t_C	–	4TCL – 30 + 2t_A + t_C	ns
Data hold after $\overline{RD}$ rising edge	t_{18}	SR	0	–	0	–	ns
Data float after $\overline{RD}$ rising edge (with RW-delay [1)])	t_{20}	SR	–	35 + t_F	–	2TCL – 15 + 2t_A + t_F [1)]	ns
Data float after $\overline{RD}$ rising edge (no RW-delay [1)])	t_{21}	SR	–	15 + t_F	–	TCL – 10 + 2t_A + t_F [1)]	ns
Data valid to $\overline{WR}$	t_{22}	CC	25 + t_C	–	2TCL – 25 + t_C	–	ns
Data hold after $\overline{WR}$	t_{24}	CC	15 + t_F	–	TCL – 10 + t_F	–	ns

Parameter	Symbol		Max. CPU Clock = 20 MHz		Variable CPU Clock 1/2TCL = 1 to 20 MHz		Unit
			min.	max.	min.	max.	
ALE rising edge after $\overline{RD}$, $\overline{WR}$	t_{26}	CC	– 10 + t_F	–	– 10 + t_F	–	ns
Address hold after $\overline{RD}$, $\overline{WR}$	t_{28}	CC	0 + t_F	–	0 + t_F	–	ns
ALE falling edge to $\overline{CS}$	t_{38}	CC	– 5 – t_A	10 – t_A	–5 – t_A	10 – t_A	ns
$\overline{CS}$ low to Valid Data In	t_{39}	SR	–	55 + t_C + 2t_A	–	3TCL – 20 + t_C + 2t_A	ns
$\overline{CS}$ hold after $\overline{RD}$, $\overline{WR}$	t_{41}	CC	10 + t_F	–	TCL – 15 + t_F	–	ns
ALE falling edge to $\overline{RdCS}$, $\overline{WrCS}$ (with RW-delay)	t_{42}	CC	20 + t_A	–	TCL – 5 + t_A	–	ns
ALE falling edge to $\overline{RdCS}$, $\overline{WrCS}$ (no RW-delay)	t_{43}	CC	– 5 + t_A	–	– 5 + t_A	–	ns
$\overline{RdCS}$ to Valid Data In (with RW-delay)	t_{46}	SR	–	25 + t_C	–	2TCL – 25 + t_C	ns
$\overline{RdCS}$ to Valid Data In (no RW-delay)	t_{47}	SR	–	50 + t_C	–	3TCL – 25 + t_C	ns
$\overline{RdCS}$, $\overline{WrCS}$ Low Time (with RW-delay)	t_{48}	CC	40 + t_C	–	2TCL – 10 + t_C	–	ns
$\overline{RdCS}$, $\overline{WrCS}$ Low Time (no RW-delay)	t_{49}	CC	65 + t_C	–	3TCL – 10 + t_C	–	ns
Data valid to $\overline{WrCS}$	t_{50}	CC	35 + t_C	–	2TCL – 15 + t_C	–	ns
Data hold after $\overline{RdCS}$	t_{51}	SR	0	–	0	–	ns
Data float after $\overline{RdCS}$ (with RW-delay)	t_{53}	SR	–	30 + t_F	–	2TCL – 20 + t_F	ns
Data float after $\overline{RdCS}$ (no RW-delay)	t_{68}	SR	–	5 + t_F	–	TCL – 20 + t_F	ns
Address hold after $\overline{RdCS}$, $\overline{WrCS}$	t_{55}	CC	– 10 + t_F	–	– 10 + t_F	–	ns
Data hold after $\overline{WrCS}$	t_{57}	CC	10 + t_F	–	TCL – 15 + t_F	–	ns

[1] RW-delay and t_A refer to the next following bus cycle.

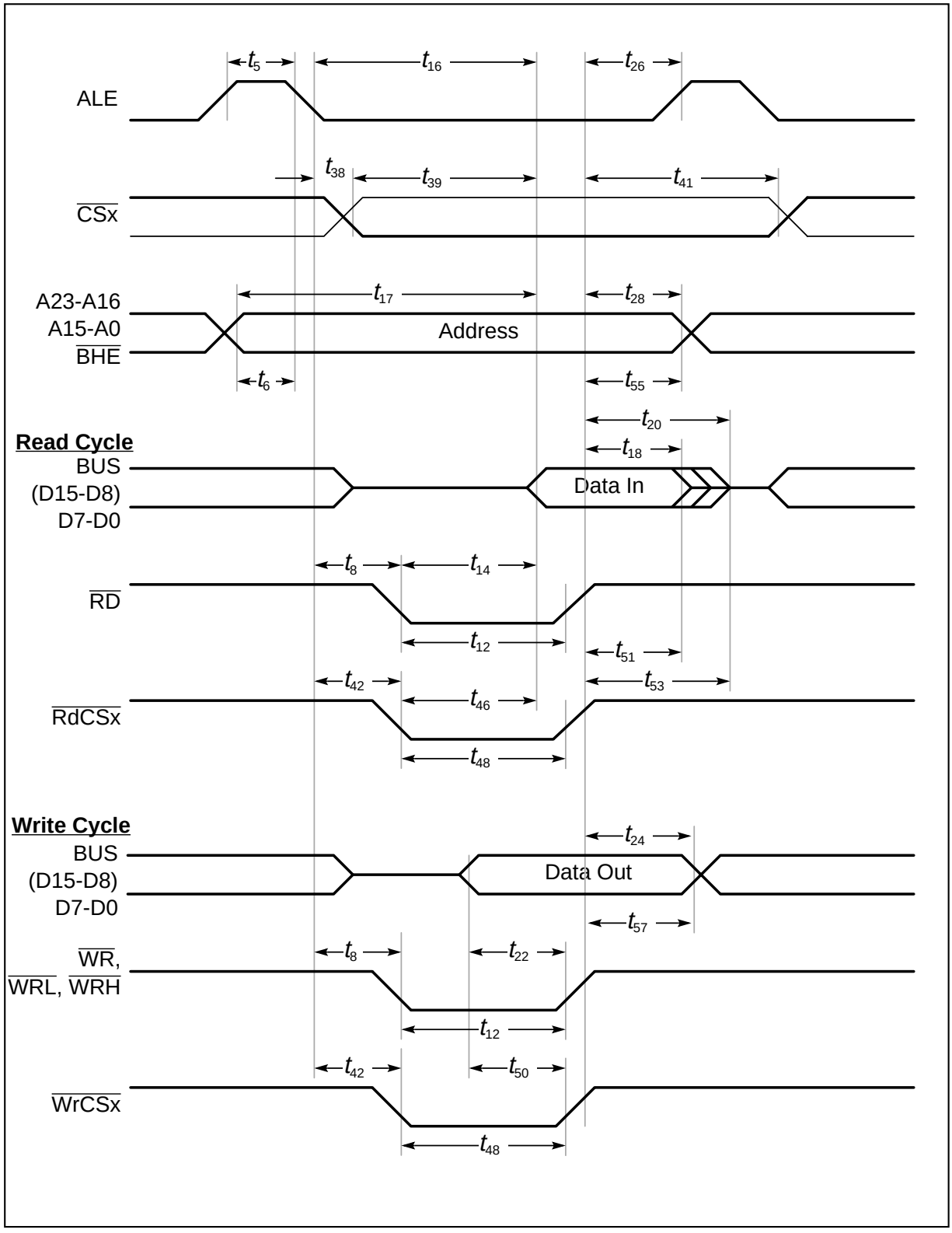


Figure 15-1
External Memory Cycle: Demultiplexed Bus, With Read/Write Delay, Normal ALE

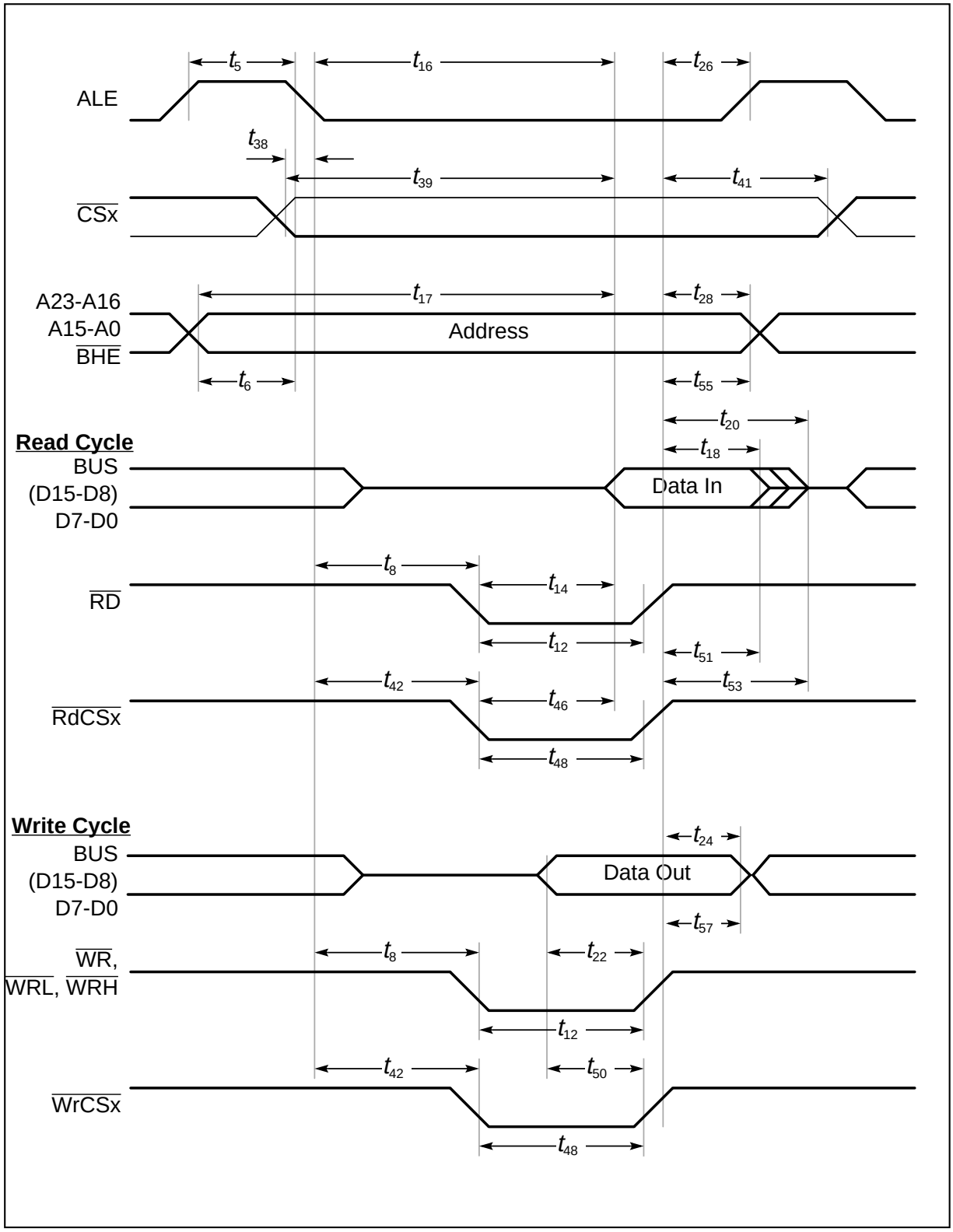


Figure 15-2
External Memory Cycle: Demultiplexed Bus, With Read/Write Delay, Extended ALE

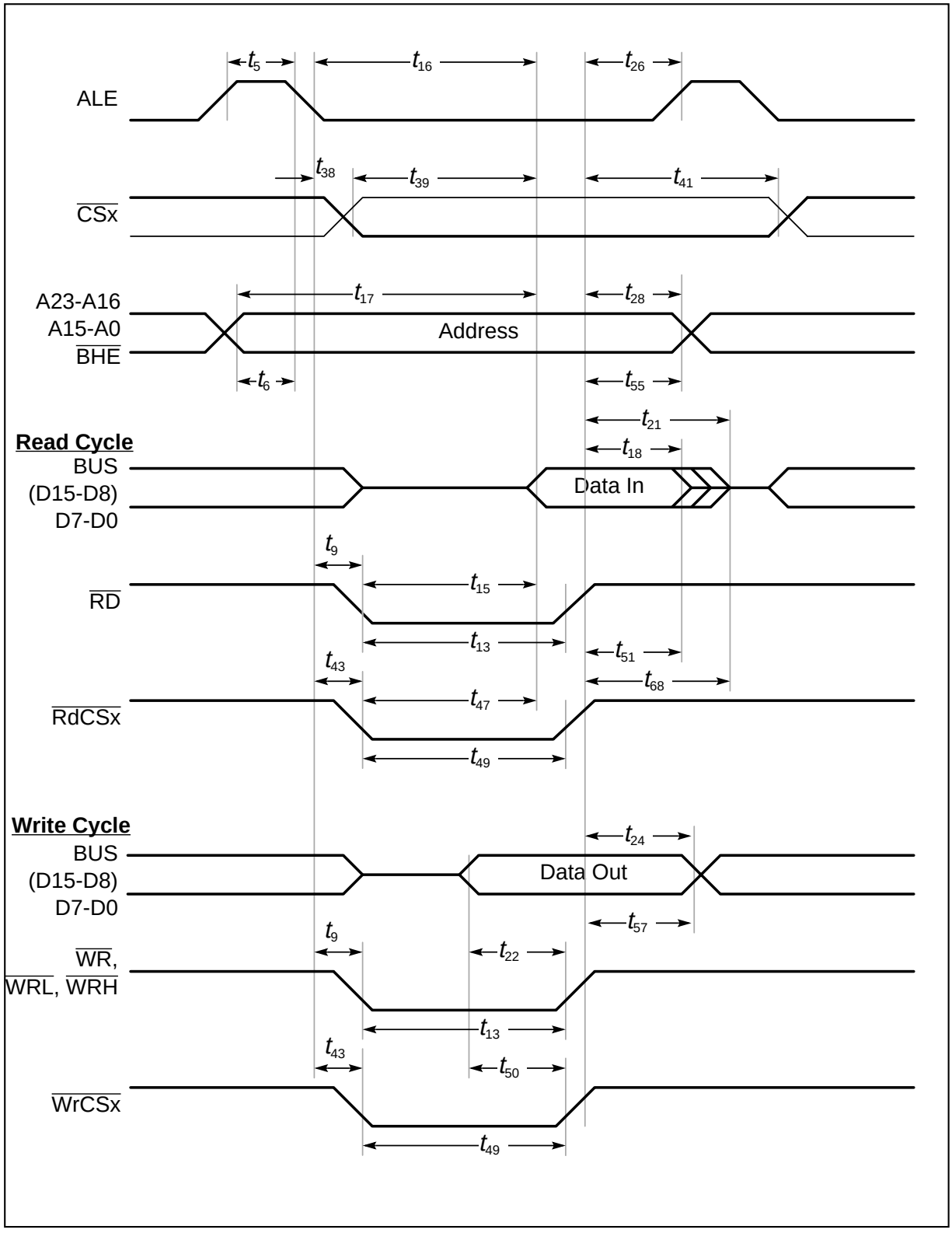


Figure 15-3
External Memory Cycle: Demultiplexed Bus, No Read/Write Delay, Normal ALE

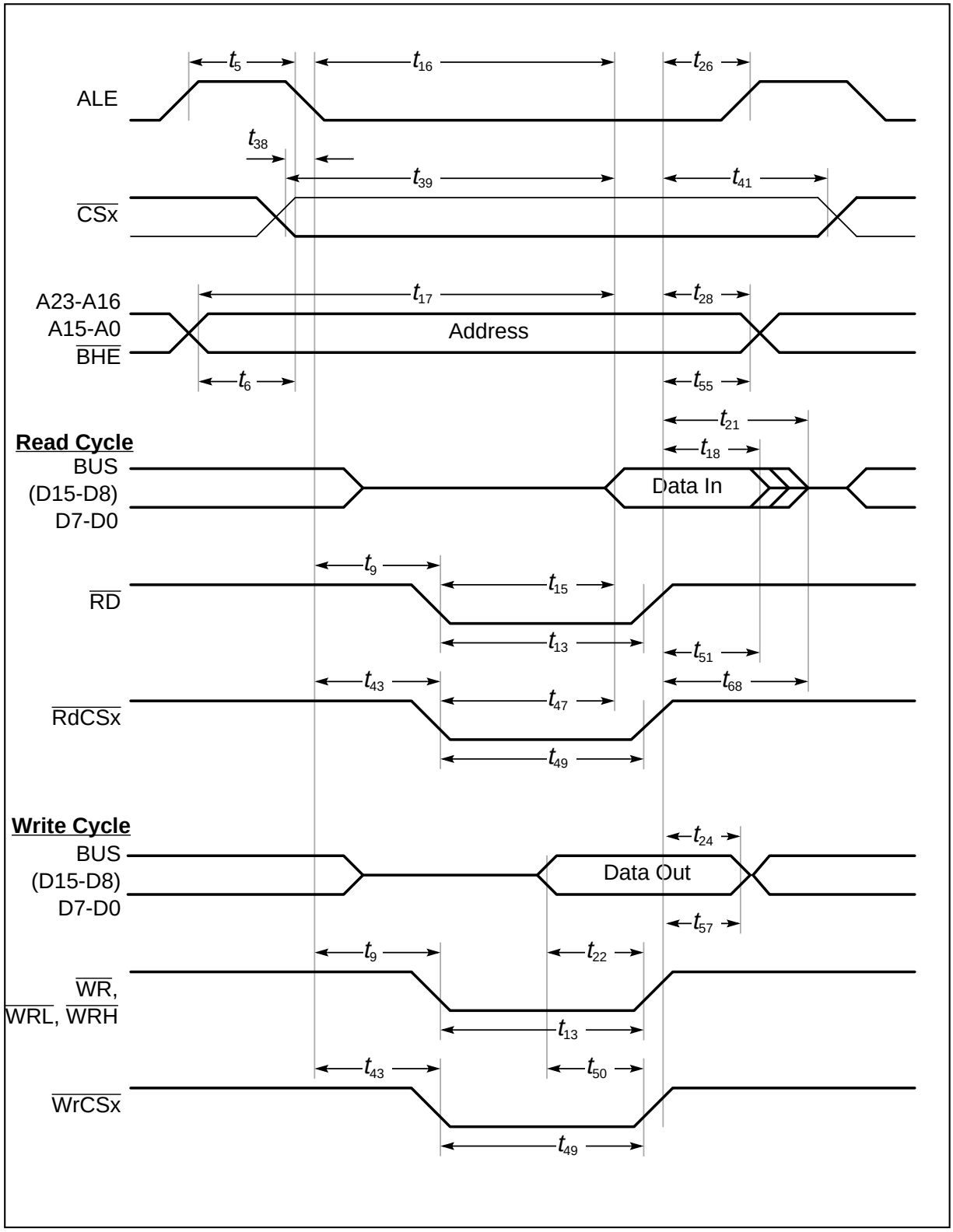


Figure 15-4
External Memory Cycle: Demultiplexed Bus, No Read/Write Delay, Extended ALE

AC Characteristics
CLKOUT and $\overline{\text{READY}}$

V_{CC} = 5 V ± 10 %; V_{SS} = 0 V
T_A = 0 to +70 °C for SAB-C167CR-LM
T_A = -40 to +85 °C for SAF-C167CR-LM
T_A = -40 to +125 °C for SAK-C167CR-LM
C_L (for PORT0, PORT1, Port 4, ALE, $\overline{\text{RD}}$, $\overline{\text{WR}}$, $\overline{\text{BHE}}$, CLKOUT) = 100 pF
C_L (for Port 6, $\overline{\text{CS}}$) = 100 pF

Parameter	Symbol		Max. CPU Clock = 20 MHz		Variable CPU Clock 1/2TCL = 1 to 20 MHz		Unit
			min.	max.	min.	max.	
CLKOUT cycle time	t_{29}	CC	50	50	2TCL	2TCL	ns
CLKOUT high time	t_{30}	CC	20	–	TCL – 5	–	ns
CLKOUT low time	t_{31}	CC	15	–	TCL – 10	–	ns
CLKOUT rise time	t_{32}	CC	–	5	–	5	ns
CLKOUT fall time	t_{33}	CC	–	5	–	5	ns
CLKOUT rising edge to ALE falling edge	t_{34}	CC	0 + t_A	10 + t_A	0 + t_A	10 + t_A	ns
Synchronous $\overline{\text{READY}}$ setup time to CLKOUT	t_{35}	SR	15	–	15	–	ns
Synchronous $\overline{\text{READY}}$ hold time after CLKOUT	t_{36}	SR	0	–	0	–	ns
Asynchronous $\overline{\text{READY}}$ low time	t_{37}	SR	65	–	2TCL + 15	–	ns
Asynchronous $\overline{\text{READY}}$ setup time [1]	t_{58}	SR	15	–	15	–	ns
Asynchronous $\overline{\text{READY}}$ hold time [1]	t_{59}	SR	0	–	0	–	ns
Async. $\overline{\text{READY}}$ hold time after $\overline{\text{RD}}$, $\overline{\text{WR}}$ high (Demultiplexed Bus) [2]	t_{60}	SR	0	0 + $2t_A$ + t_F [2]	0	TCL - 25 + $2t_A$ + t_F [2]	ns

Notes

1) These timings are given for test purposes only, in order to assure recognition at a specific clock edge.

2) Demultiplexed bus is the worst case. For multiplexed bus 2TCL are to be added to the maximum values. This adds even more time for deactivating $\overline{\text{READY}}$.
The $2t_A$ refer to the next following bus cycle.

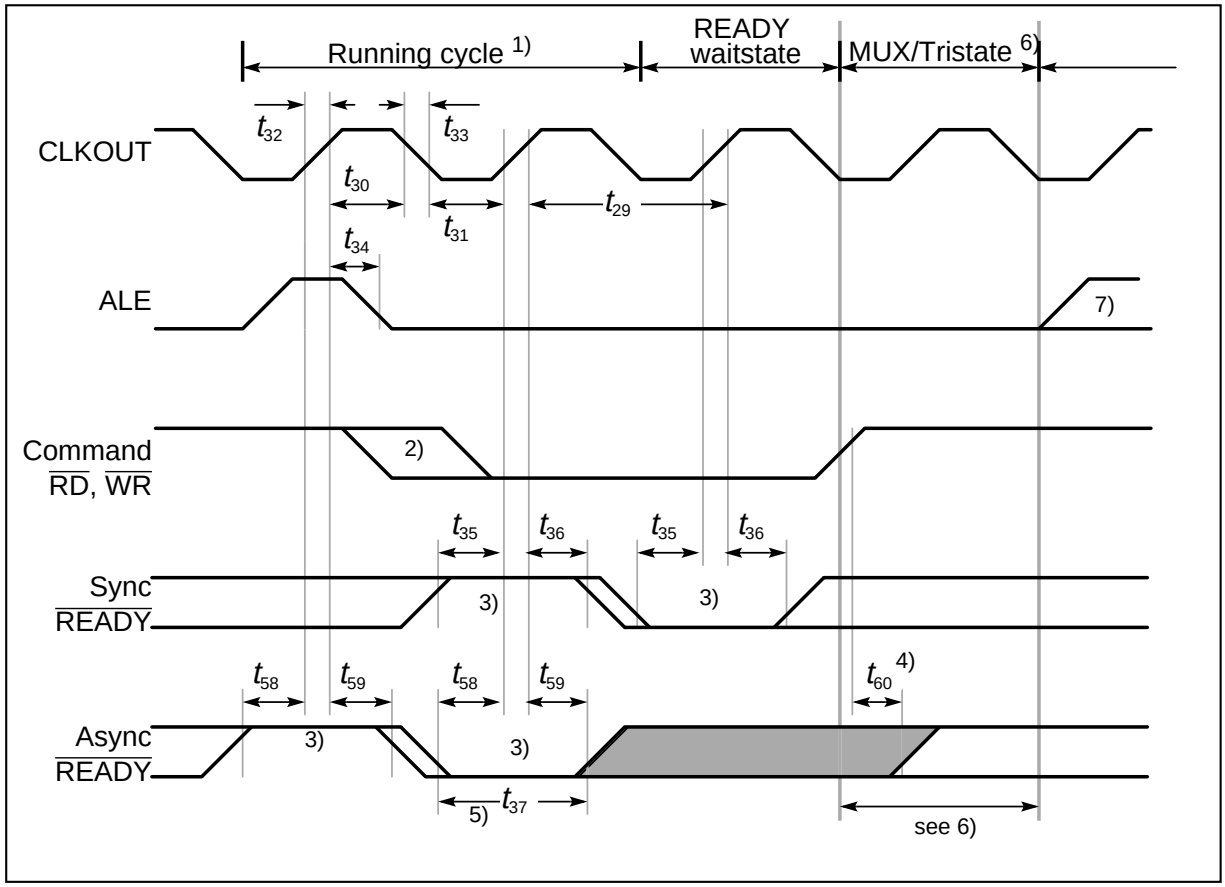


Figure 16
CLKOUT and READY

Notes

1) Cycle as programmed, including MCTC waitstates (Example shows 0 MCTC WS).

2) The leading edge of the respective command depends on RW-delay.

3) READY sampled HIGH at this sampling point generates a READY controlled waitstate,
READY sampled LOW at this sampling point terminates the currently running bus cycle.

4) READY may be deactivated in response to the trailing (rising) edge of the corresponding command (RD or WR).

5) If the Asynchronous READY signal does not fulfill the indicated setup and hold times with respect to CLKOUT (e.g. because CLKOUT is not enabled), it must fulfill t_{37} in order to be safely synchronized. This is guaranteed, if READY is removed in response to the command (see Note 4)).

6) Multiplexed bus modes have a MUX waitstate added after a bus cycle, and an additional MTTC waitstate may be inserted here.
For a multiplexed bus with MTTC waitstate this delay is 2 CLKOUT cycles, for a demultiplexed bus without MTTC waitstate this delay is zero.

7) The next external bus cycle may start here.

AC Characteristics
External Bus Arbitration

V_{CC} = 5 V ± 10 %; V_{SS} = 0 V
T_A = 0 to + 70 °C for SAB-C167CR-LM
T_A = – 40 to + 85 °C for SAF-C167CR-LM
T_A = – 40 to + 125 °C for SAK-C167CR-LM
C_L (for PORT0, PORT1, Port 4, ALE, $\overline{RD}$, $\overline{WR}$, $\overline{BHE}$, CLKOUT) = 100 pF
C_L (for Port 6, $\overline{CS}$) = 100 pF

Parameter	Symbol		Max. CPU Clock = 20 MHz		Variable CPU Clock 1/2TCL = 1 to 20 MHz		Unit
			min.	max.	min.	max.	
$\overline{HOLD}$ input setup time to CLKOUT	t_{61}	SR	20	–	20	–	ns
CLKOUT to $\overline{HLDA}$ high or $\overline{BREQ}$ low delay	t_{62}	CC	–	20	–	20	ns
CLKOUT to $\overline{HLDA}$ low or $\overline{BREQ}$ high delay	t_{63}	CC	–	20	–	20	ns
$\overline{CSx}$ release	t_{64}	CC	–	20	–	20	ns
$\overline{CSx}$ drive	t_{65}	CC	– 5	25	– 5	25	ns
Other signals release	t_{66}	CC	–	20	–	20	ns
Other signals drive	t_{67}	CC	– 5	25	– 5	25	ns

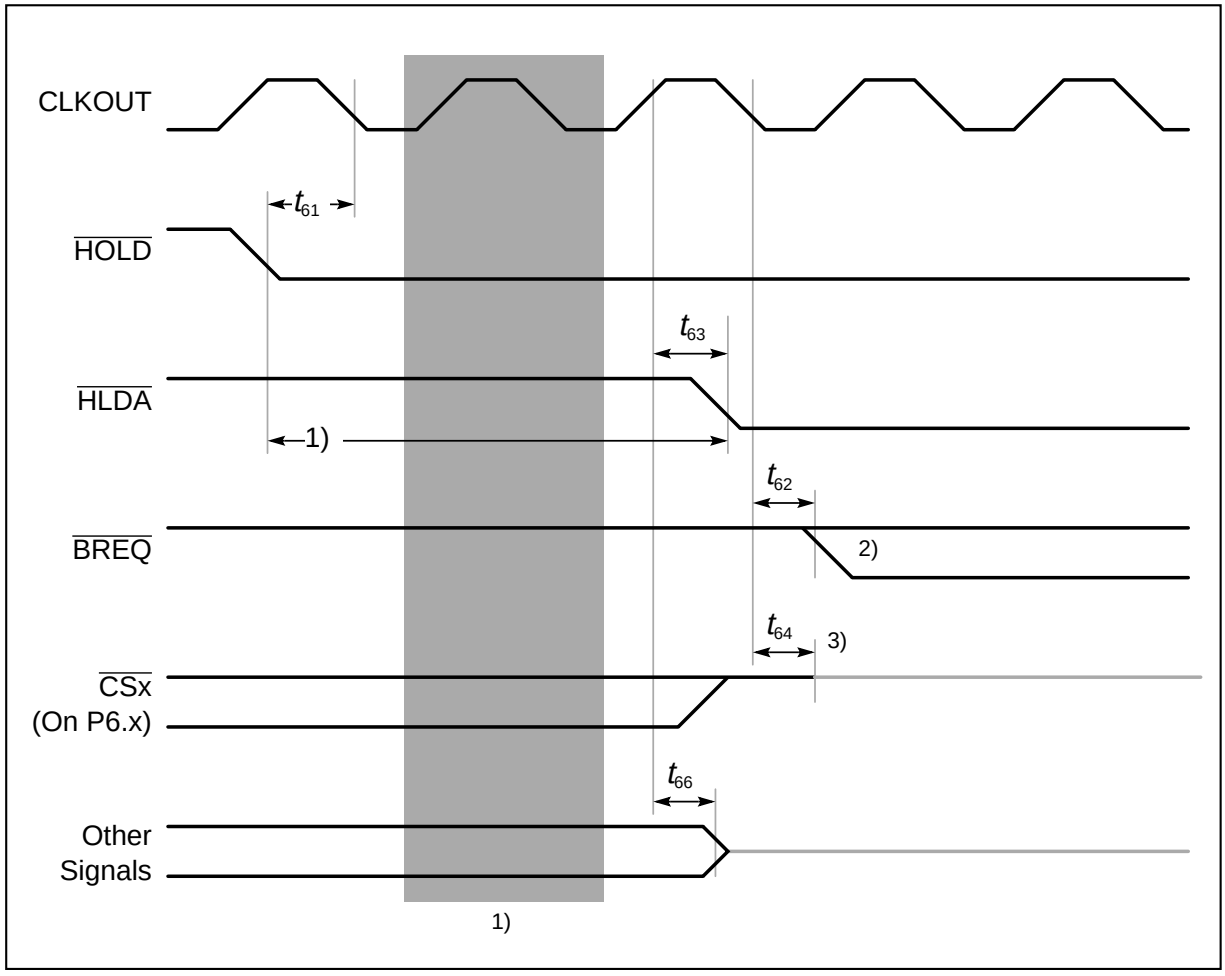


Figure 17
External Bus Arbitration, Releasing the Bus

Notes

1) The C167CR will complete the currently running bus cycle before granting bus access.

2) This is the first possibility for $\overline{\text{BREQ}}$ to get active.

3) The $\overline{\text{CS}}$ outputs will be resistive high (pullup) after t_{64}.

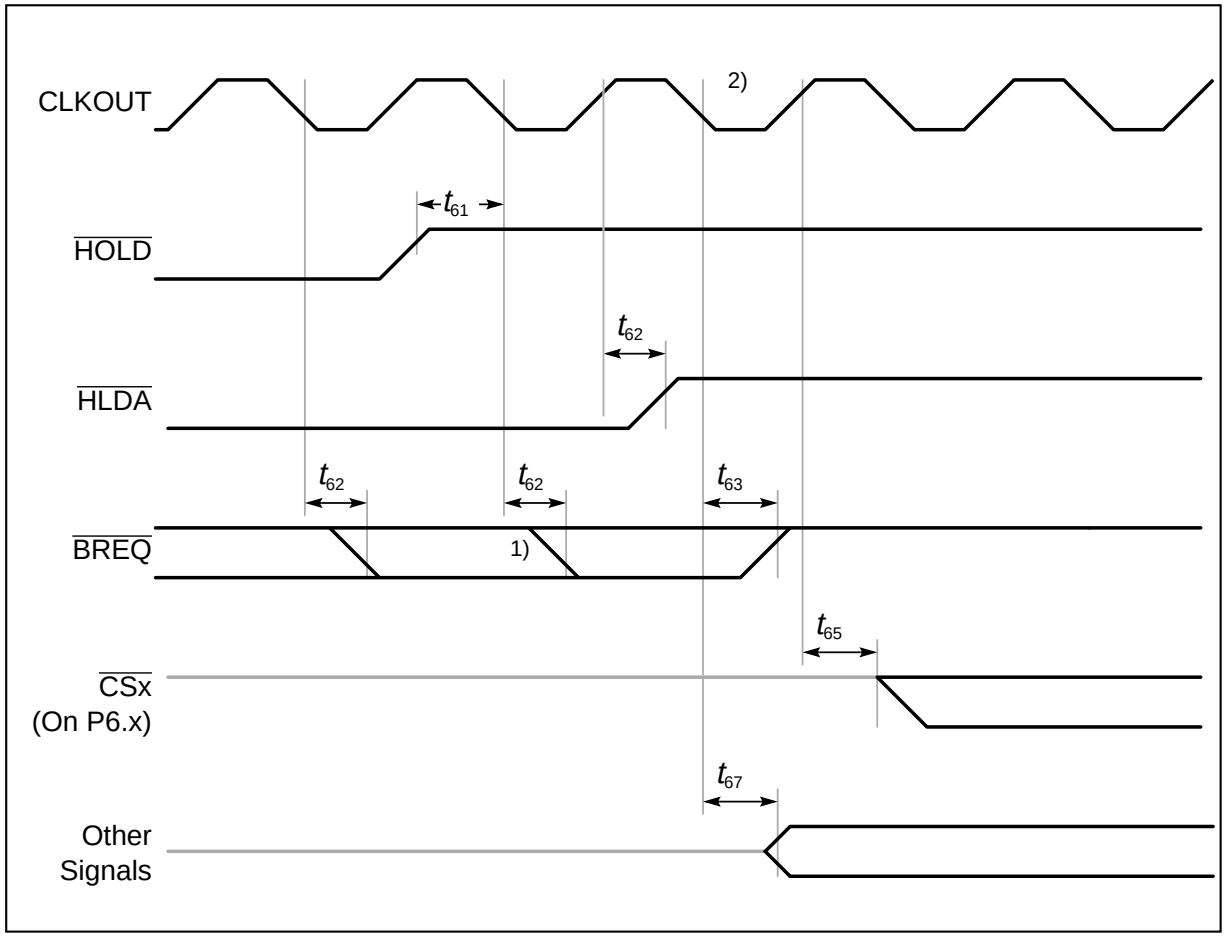


Figure 18
External Bus Arbitration, (Regaining the Bus)

Notes

1) This is the last chance for BREQ to trigger the indicated regain-sequence.
Even if BREQ is activated earlier, the regain-sequence is initiated by HOLD going high.
Please note that HOLD may also be deactivated without the C167CR requesting the bus.

2) The next C167CR driven bus cycle may start here.